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(54) **RADIATION DETECTOR AND IMAGING SYSTEM**

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(58) **Field of Classification Search**

CPC G01T 1/2006

USPC 250/366, 369, 367

See application file for complete search history.

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Primary Examiner — David Porta

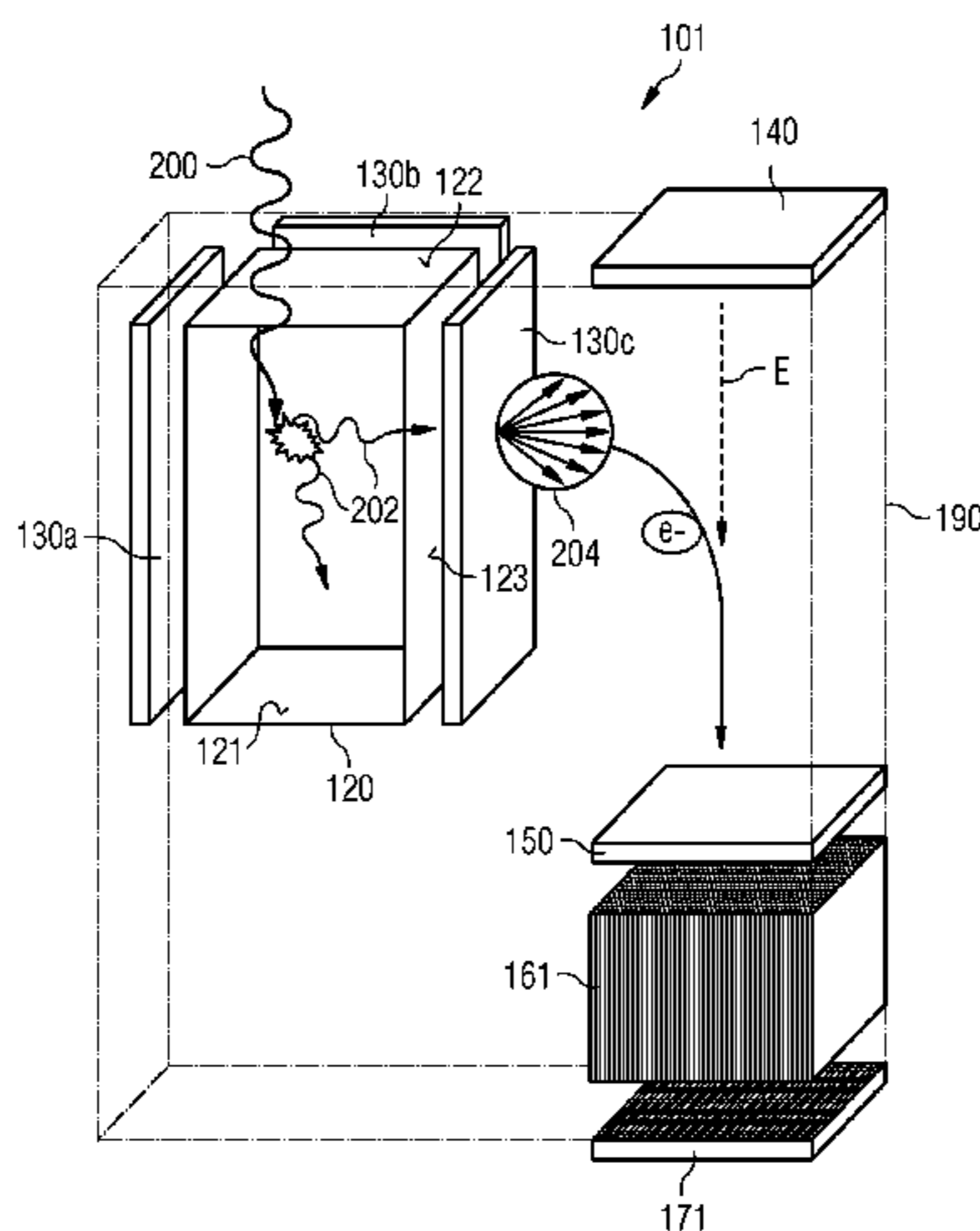
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(57) **ABSTRACT**

The invention relates to a radiation detector (100; 101; 102; 103; 104; 105; 106), having a scintillator (120) for generating electromagnetic radiation (202) in response to the action of incident radiation (200). The scintillator (120) has two opposing end faces (121; 122) and a lateral wall (123) between the end faces (121; 122). The radiation detector has, in addition, a photocathode section (130) that is located on the lateral electrons wall (123) of the scintillator (120) and that generates electrons (204) in response to the action of electromagnetic radiation (202) that is generated by the scintillator (120), a microchannel plate (161; 162) comprising a plurality of channels (165), for multiplying the electrons (204) that have been generated by the photocathode section (130) and a detection system (171; 172) for detecting the electrons (204) that have been multiplied by means of the microchannel plate (161; 162). The invention also relates to an imaging system (110) comprising a radiation detector of this type (100; 101; 102; 103; 104; 105; 106).

11 Claims, 9 Drawing Sheets



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FIG 1

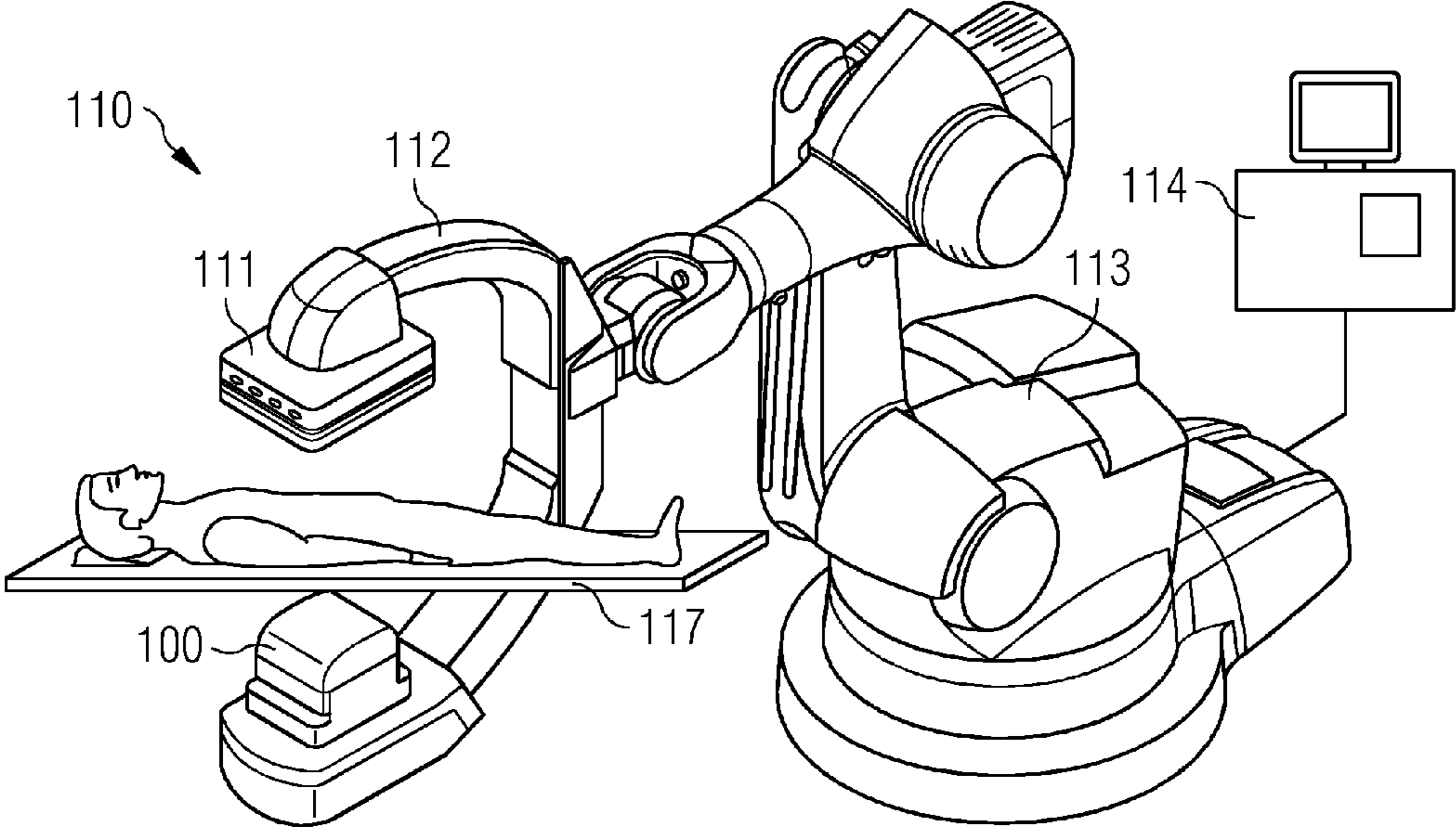


FIG 2

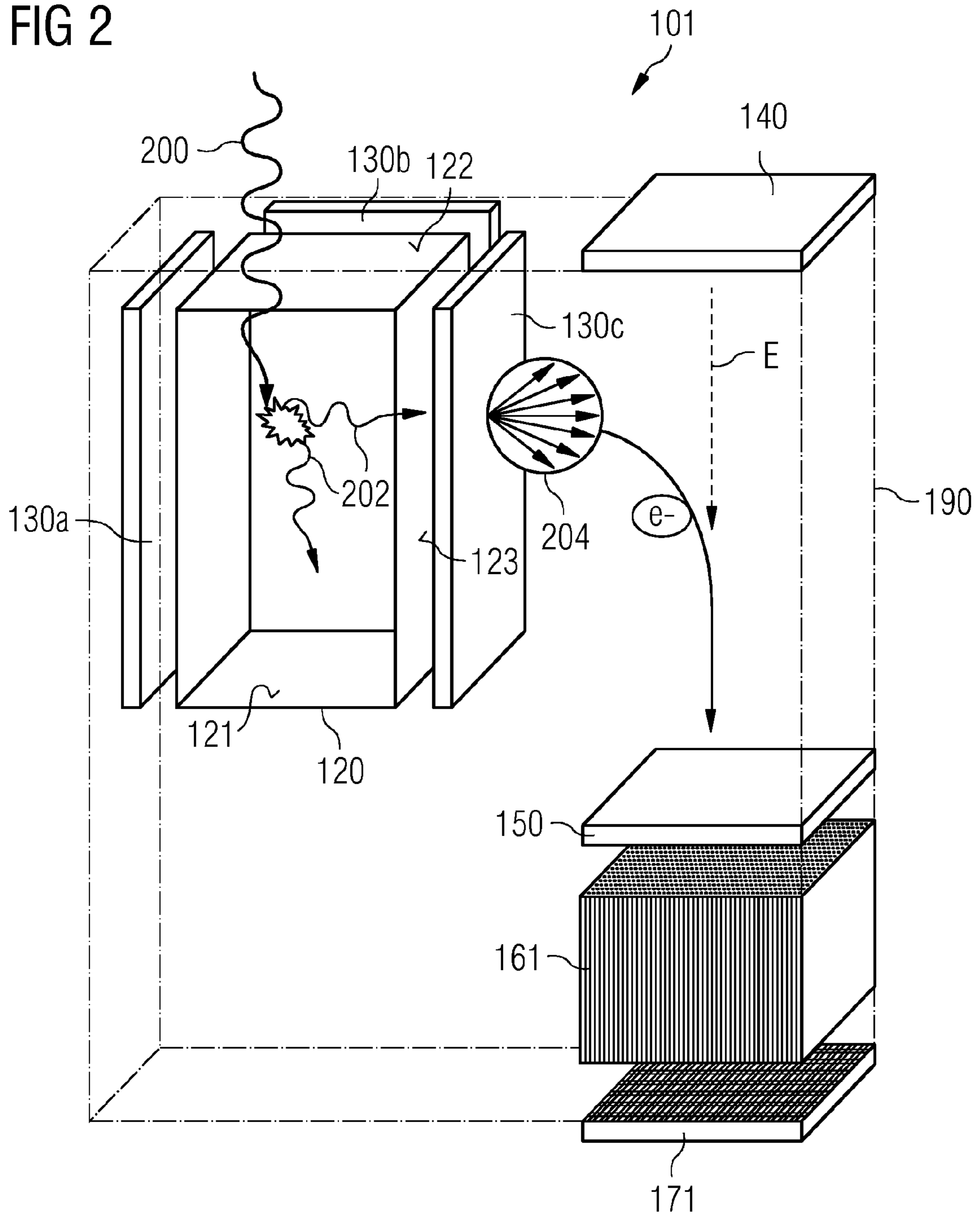


FIG 3

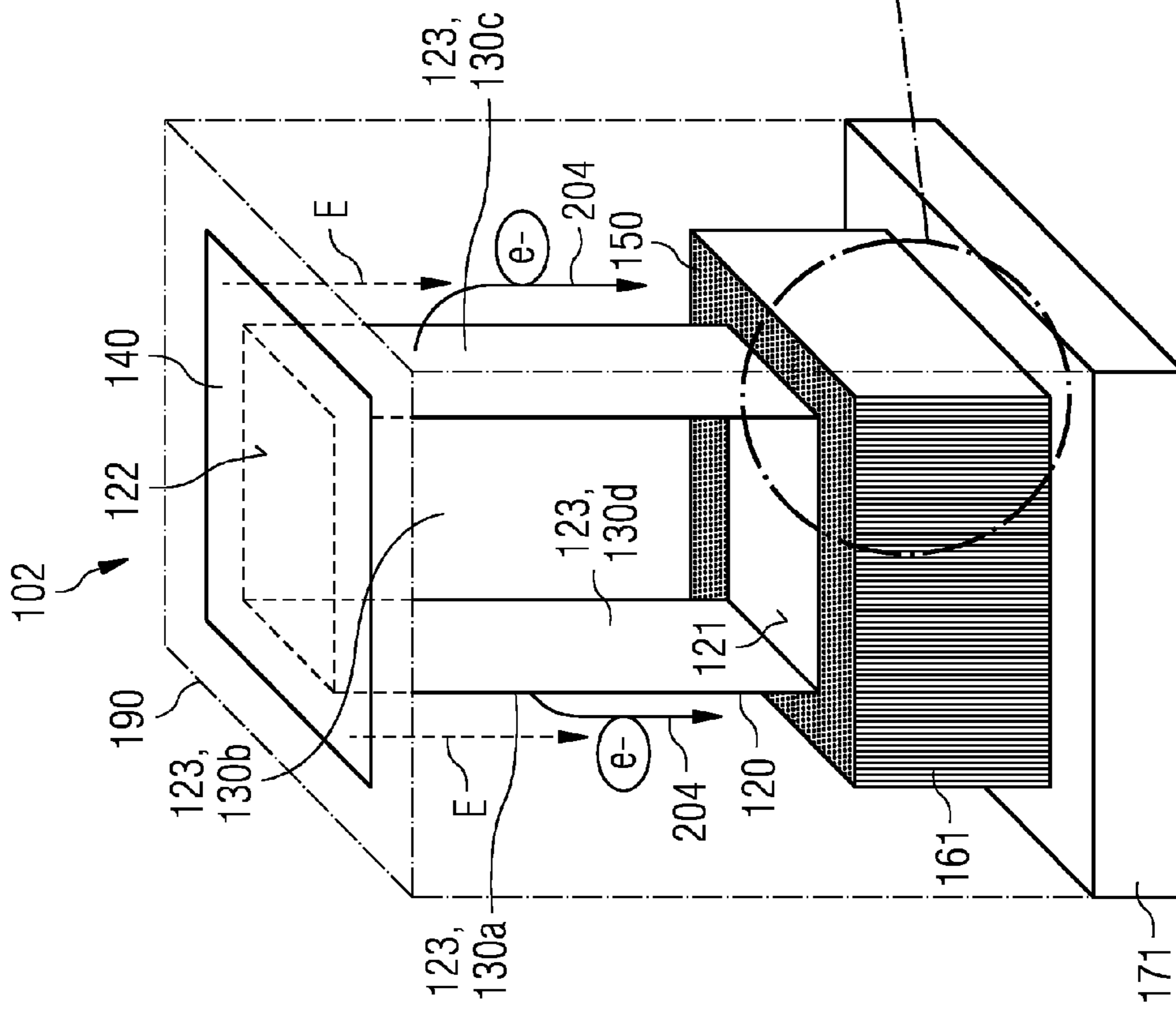


FIG 4

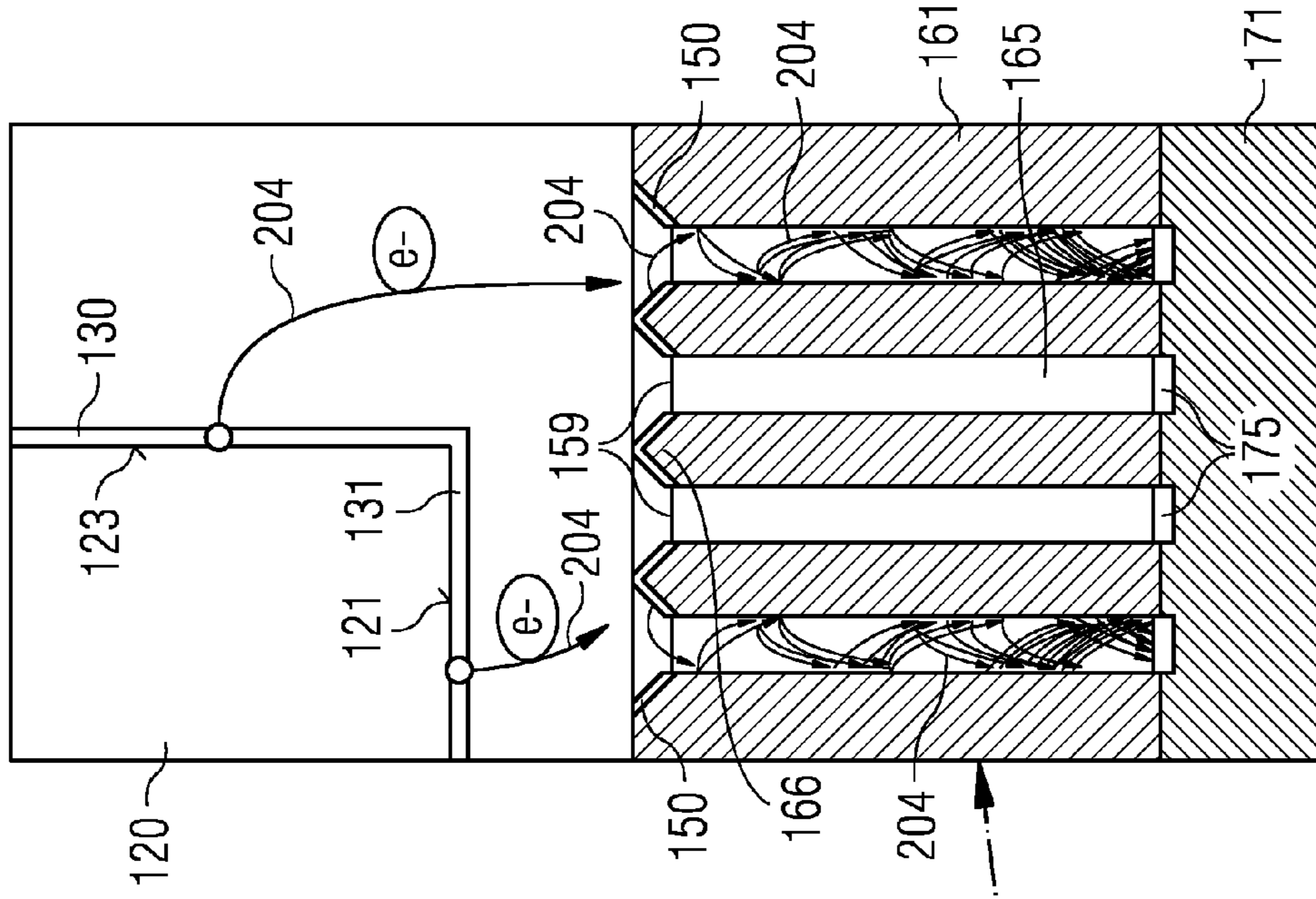


FIG 5

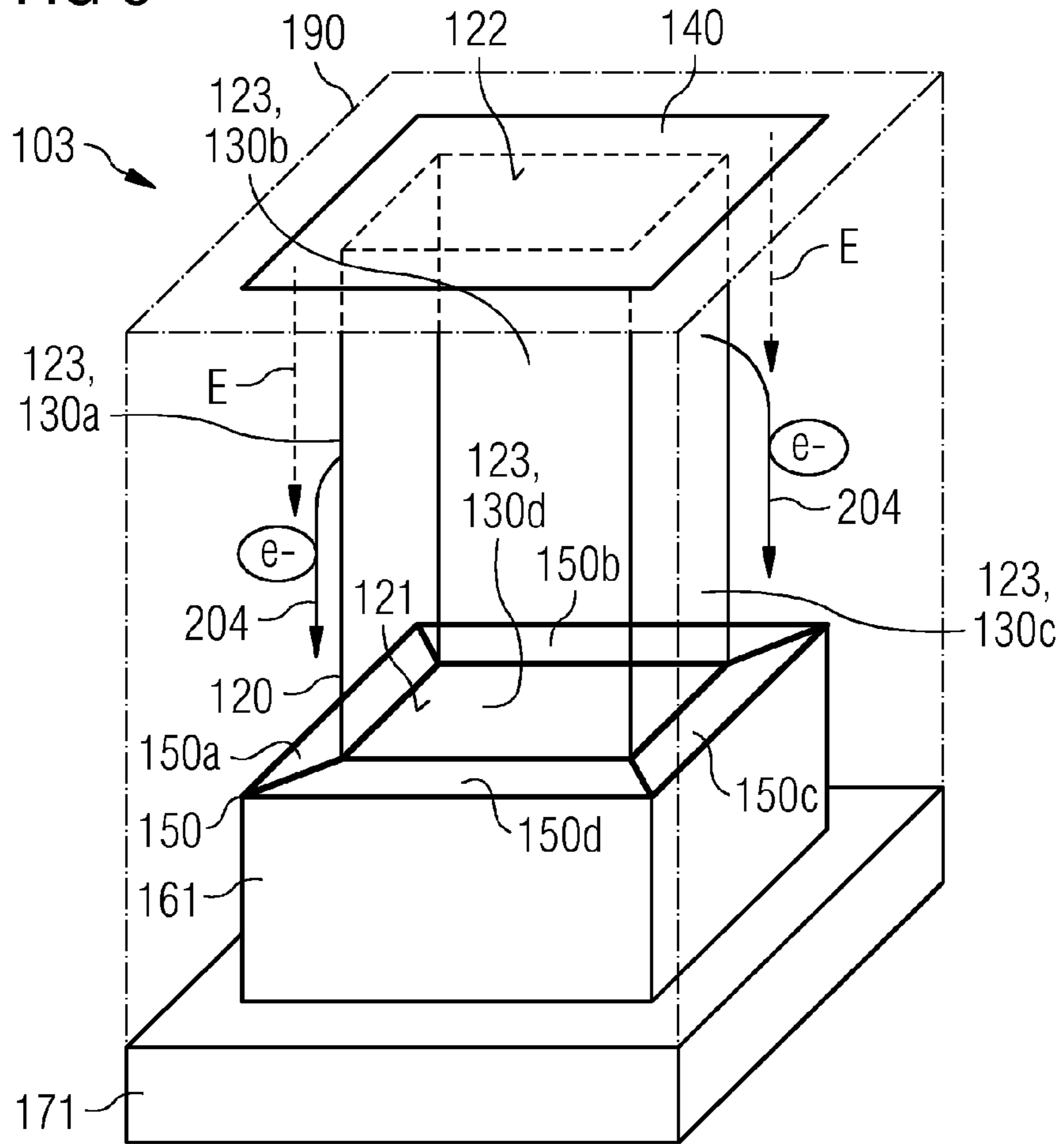


FIG 6

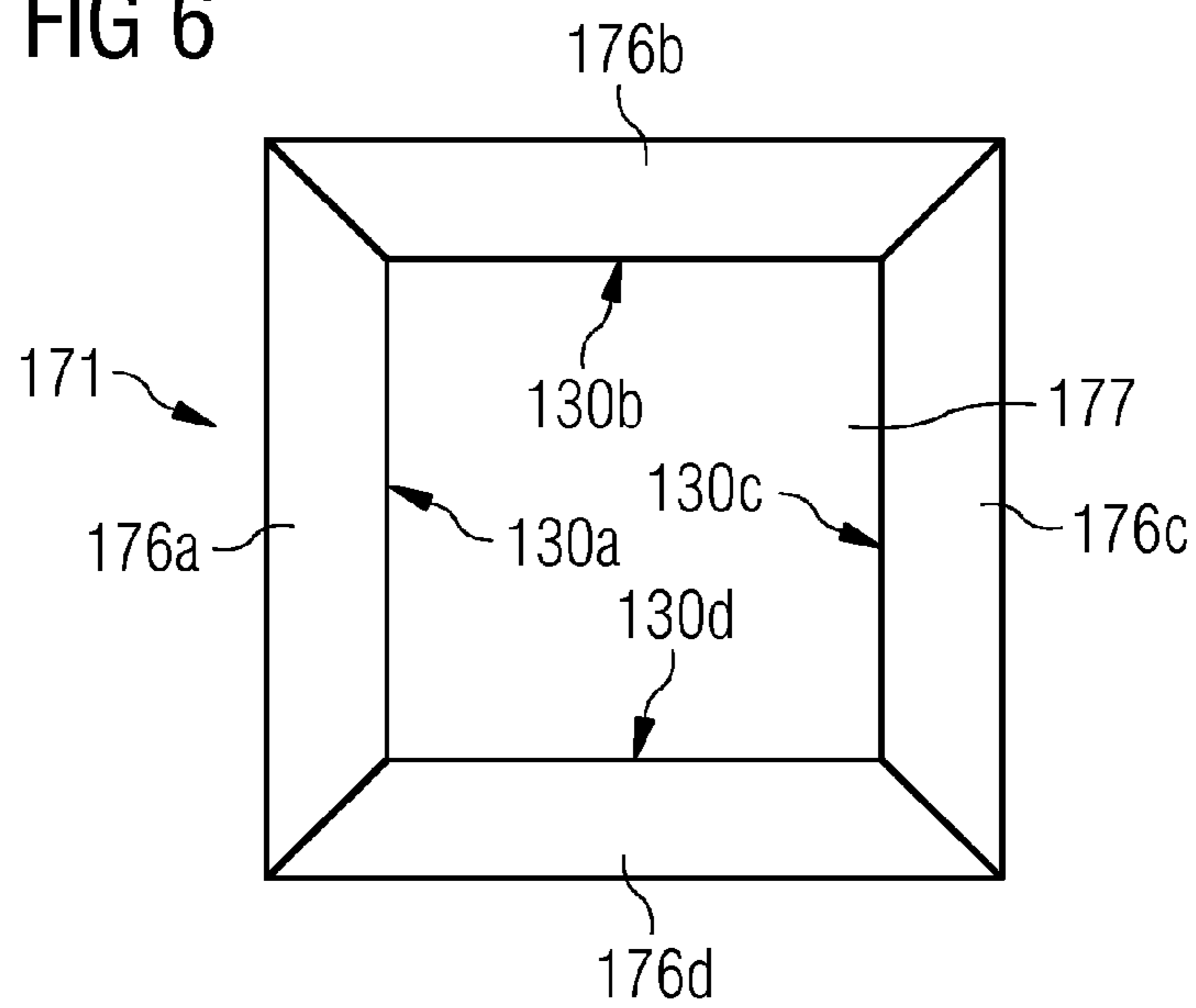


FIG 7

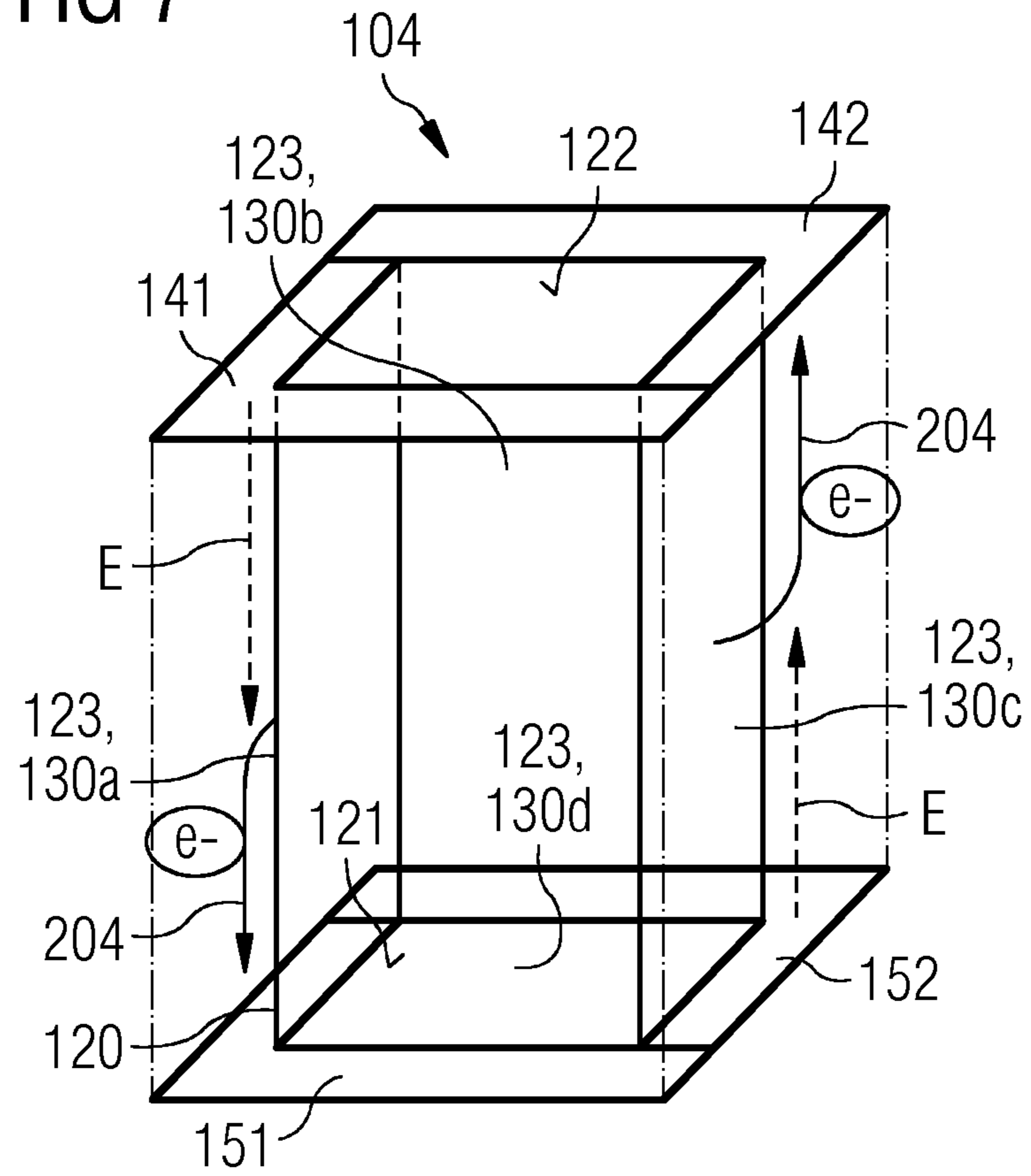


FIG 8

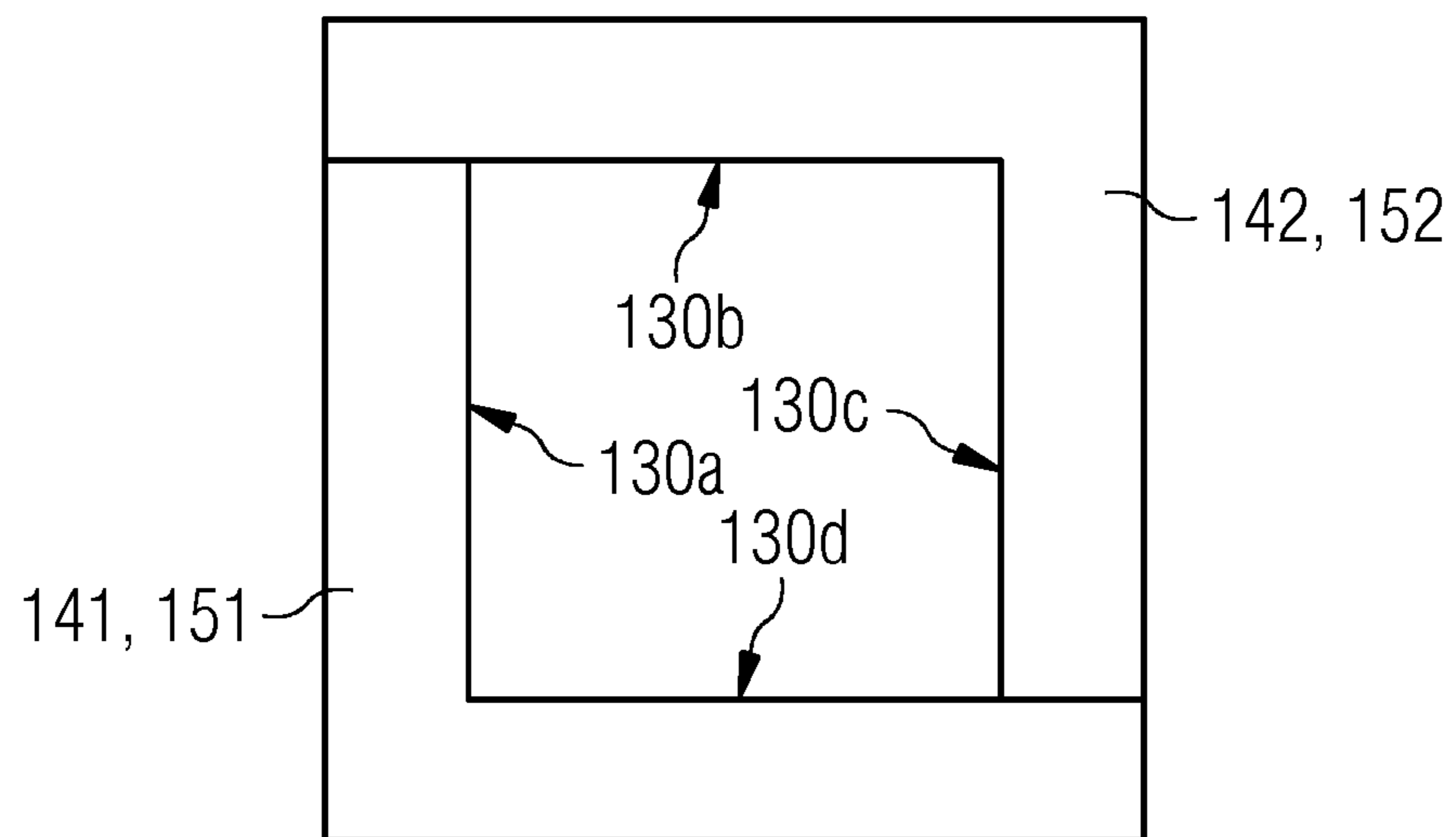
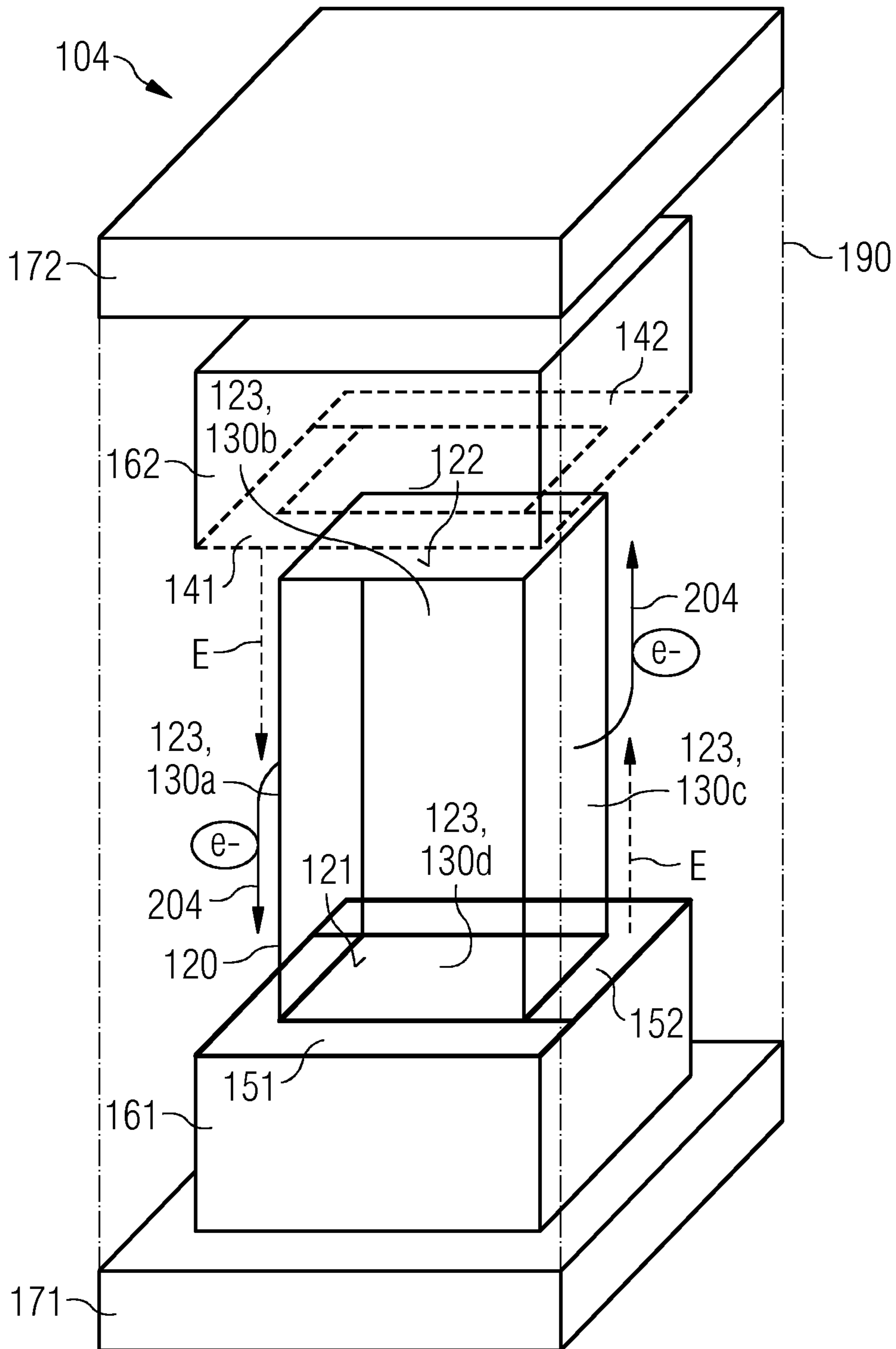


FIG 9



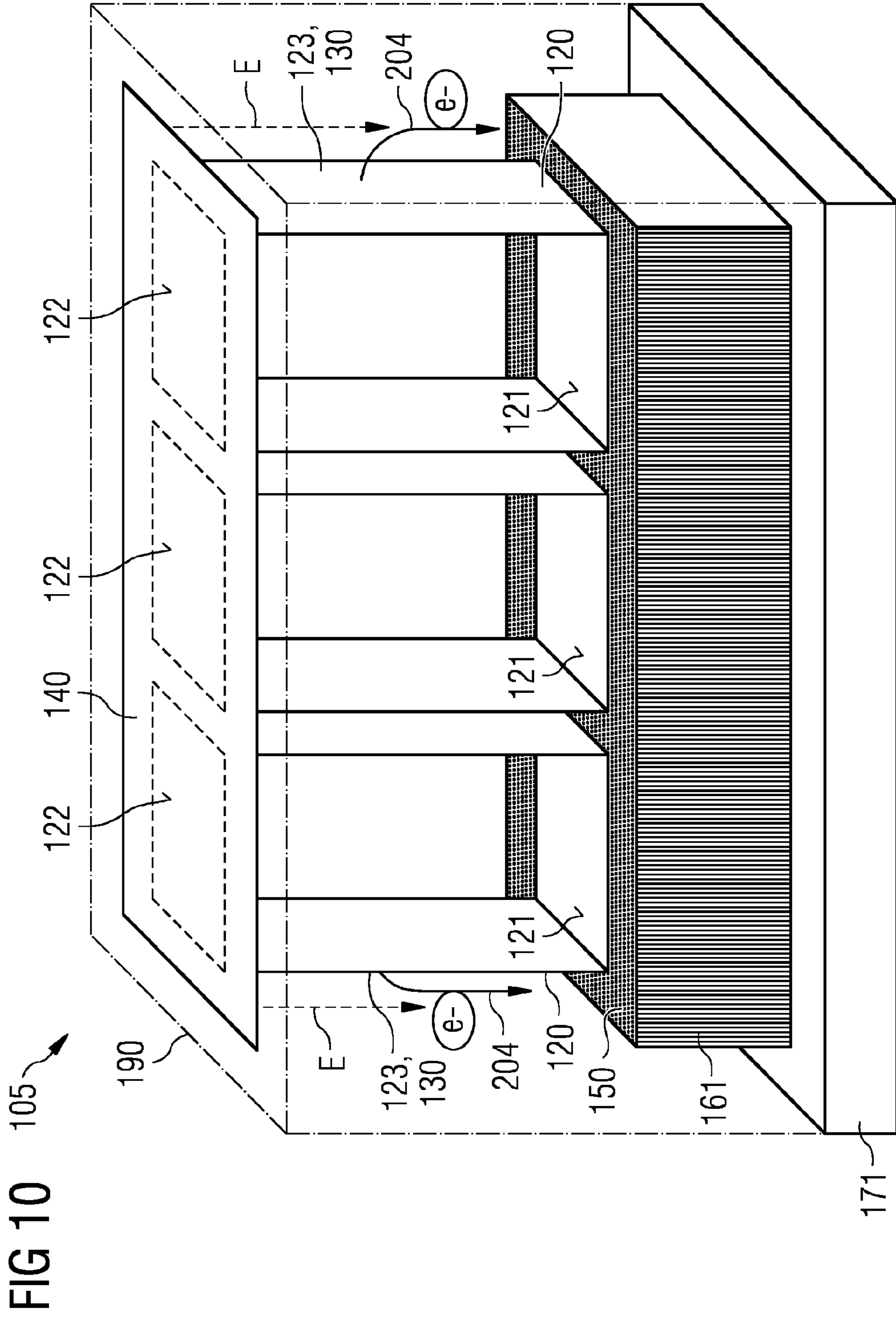


FIG 11

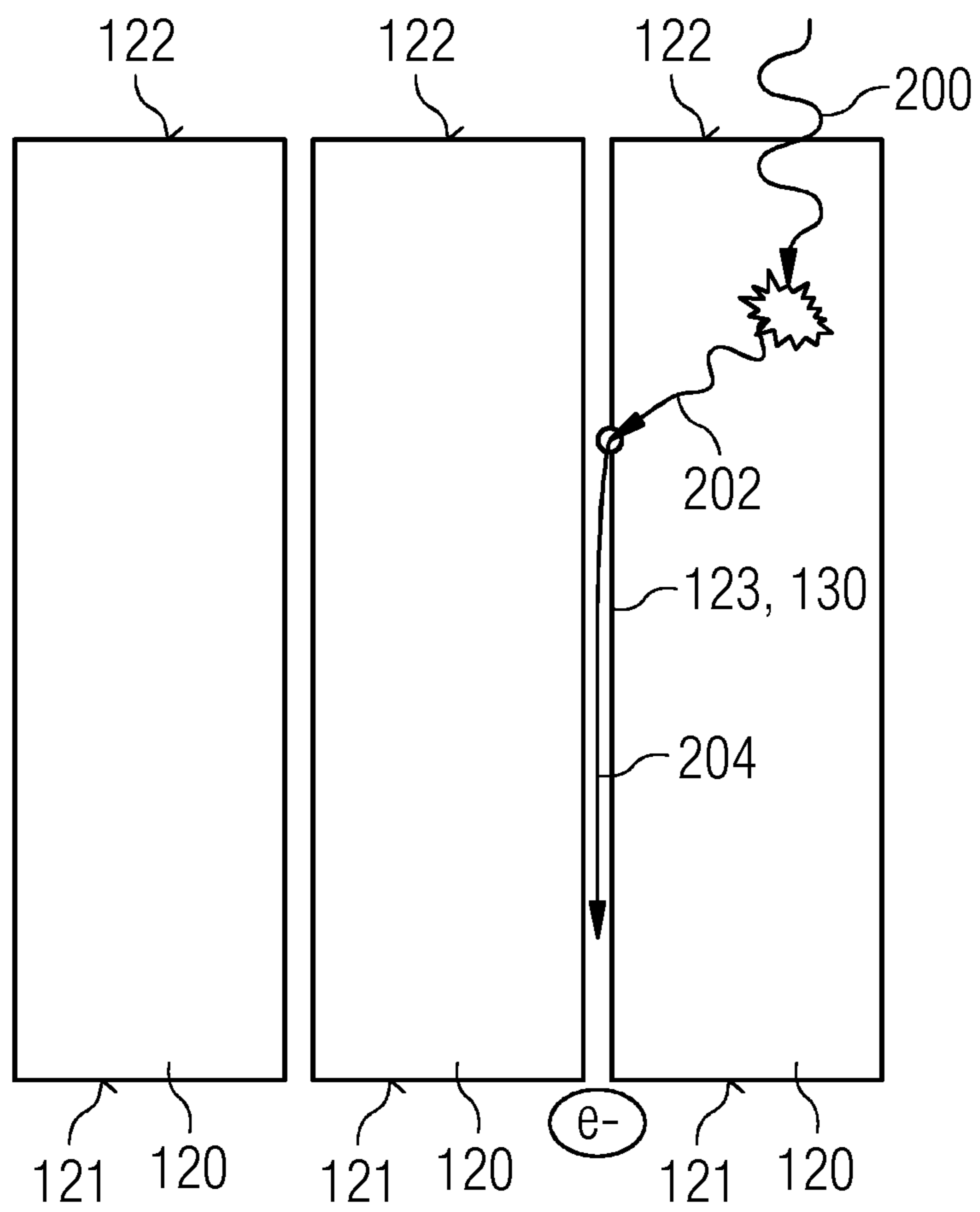
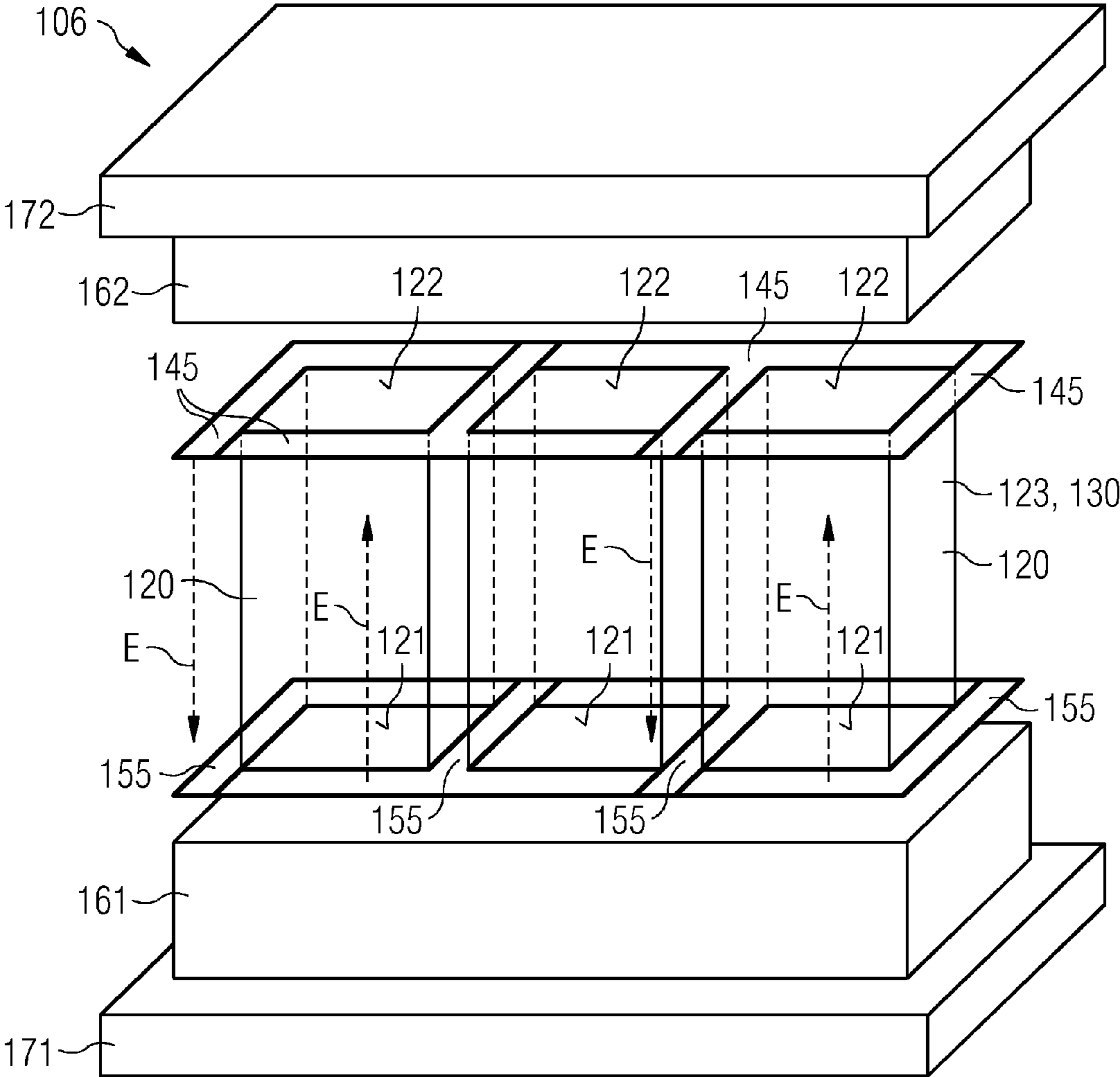


FIG 12



RADIATION DETECTOR AND IMAGING SYSTEM

This application is the National Stage of International Application No. PCT/EP2012/059388, filed May 21, 2012, which claims the benefit of German Patent Application No. DE 10 2011 077 057.7, filed Jun. 7, 2011. The entire contents of these documents are hereby incorporated herein by reference.

BACKGROUND

The present embodiments relate to a radiation detector that may be used to detect electromagnetic radiation.

Imaging systems appertaining to medical technology are becoming increasingly important nowadays. Systems of this type are used to generate two- or three-dimensional image data of organs and structures of the human body, which may be used, for example, for diagnosing causes of illness, for carrying out operations, and for preparing therapeutic measures. The image data may be generated based on measurement signals obtained with the aid of a radiation detector.

This is the case, for example, in X-ray and computed tomography systems (CT). In systems of this type, the body or a body section of a patient to be examined is radiographed by X-ray radiation generated by a radiation source. The non-absorbed, transmitted portion of radiation is detected by a detector.

A further example is image generation with the aid of radionuclides, such as is used in positron emission tomography systems (PET) and single photon emission computer tomography systems (SPECT). In this case, the patient to be examined is injected with a radiopharmaceutical that generates gamma quanta either directly (SPECT) or indirectly (PET) through emission of positrons. The gamma radiation is detected by a corresponding radiation detector.

Detectors that may be used for the energy-resolved detection or “counting” of radiation quanta may operate according to different measurement principles. Radiation may be detected either directly (e.g., by direct conversion of the radiation energy into electrical energy) or indirectly. In the case of the last-mentioned variant, use is generally made of a scintillator, which is excited in response to the action of radiation to be detected and reemits the excitation energy by emitting lower-energy electromagnetic radiation. Only the radiation emitted by the scintillator is converted into electrical measurement signals in this case. Detectors of planar construction (e.g., “flat detectors”) that are used in the medical field and operate in accordance with these measurement principles are described, for example, in M. Spahn, “Flat detectors and their clinical applications,” *Eur Radiol* (2005), 15: 1934-1947.

The conversion of the radiation emerging from a scintillator into an electrical signal may be effected in various ways. Besides use of a photomultiplier provided with a photocathode in the form of an evacuated electron tube, one concept that is common at the present time includes using a silicon photomultiplier (“SiPM”). This involves a matrix arrangement of avalanche photodiodes (APD) embodied on a shared substrate, electrons being generated in the photodiodes as a result of incident photons, and the electrons being multiplied in an avalanche-like manner.

One disadvantage of silicon photomultipliers, however, is that only part of the total area available for irradiation may be utilized as sensitive or “active” area. The reason for this is that between the active or radiation-sensitive regions there are also insensitive regions, in which resistors and signal lines or

wiring structures are arranged. A silicon photomultiplier therefore has a relatively small ratio of active area to total area (e.g., irradiated total area). The ratio is also designated as “filling factor.” Further disadvantages include noise that occurs during operation, and a relatively high dark rate or dark count. In other words, signal generation takes place even without irradiation.

A detector including a scintillator and a silicon photomultiplier may be embodied such that the silicon photomultiplier is opposite an end face or rear side of the scintillator. An opposite end face or front side of the scintillator faces the radiation to be detected. As a result, the silicon photomultiplier may detect only that portion of the radiation converted in the scintillator that emerges at the rear side thereof. Proceeding from the respective excitation or interaction location in the scintillator, however, the scintillation radiation is emitted not only in the direction of the rear side, but also in other directions. The radiation is subject to loss processes such as reflection, absorption and scattering. In the case of scintillators having a high aspect ratio (e.g., a high ratio of height to width), as may be the case for example in a PET system, the losses are therefore relatively high. In the case of an aspect ratio of greater than 7:1, the radiation emerging from a scintillator may make up a proportion of merely 40-60% of the total radiation generated. Although a higher intensity of the incident radiation may be provided in order to compensate for the losses, as a result, a patient is also exposed to an increased radiation dose.

It is disadvantageous that an interaction location of incident radiation in the scintillator may not be detected or may be detected only with very great difficulty based on the radiation emerging at the rear side of the scintillator. It is not possible to obtain information about the height or depth of an interaction in the scintillator. Such disadvantages therefore restrict the resolution of an imaging system provided with such a detector construction.

For image intensification and for electron multiplication, it is furthermore known to use microchannel plates (MCP) having a number of channels. During operation, an electrical voltage present along the channels is generated, whereby entering electrons may be accelerated within the channels and multiplied by impacts with the channel walls. Use of a microchannel plate in connection with an image intensifier is described in US 2009/0256063 A1, for example.

SUMMARY AND DESCRIPTION

The scope of the present invention is defined solely by the appended claims and is not affected to any degree by the statements within this summary.

A solution for improved radiation detection in the medical field is specified.

A radiation detector includes a scintillator for generating electromagnetic radiation in response to the action of incident radiation. The scintillator has two mutually opposite end faces and a lateral wall between the end faces. The radiation detector also includes a photocathode section arranged on the lateral wall of the scintillator and serving for generating electrons in response to the action of the electromagnetic radiation generated by the scintillator, a microchannel plate having a plurality of channels for multiplying the electrons generated by the photocathode section, and a detection device for detecting the electrons multiplied by the microchannel plate.

During the operation of the radiation detector, with one of the end faces, the scintillator may face the radiation to be detected (e.g., X-ray or gamma radiation). The electromagnetic radiation (e.g., visible or ultraviolet light) generated by

the incident radiation in the scintillator and passing to the lateral wall thereof may be taken up or absorbed directly by the photocathode section arranged at this location, and may thus be converted directly and rapidly into electrons. The lateral wall may have a relatively large surface area in comparison with the end faces of the scintillator. As a result of this, a large part of the radiation converted in the scintillator may be utilized for generating electrons. This holds true particularly in the case of one possible configuration of the scintillator having a high aspect ratio. On account of these properties, the radiation detector may be distinguished by a high temporal resolution and high efficiency.

It is advantageous that the radiation detector may have significantly less noise and a lower dark rate compared with a conventional detector including a silicon photomultiplier. This may be attributed to the fact that without radiation of the scintillator, no electrons are generated by the photocathode section and, consequently, no electron multiplication (e.g., substantially no electron multiplication) takes place in the microchannel plate. The microchannel plate used for electron multiplication may be embodied with a high porosity, as a result of which the microchannel plate has a high filling factor (e.g., ratio of active area to irradiated total area), which may be higher (e.g., significantly) than in the case of a conventional silicon photomultiplier. This likewise fosters a high efficiency of the radiation detector.

In one embodiment, the scintillator is embodied in a parallelepipedal fashion and has four lateral walls between the end faces. A photocathode section for generating electrons is arranged on each of the four lateral walls. As a result, a significant part of the electromagnetic radiation generated in the scintillator may be converted into electrons, which is advantageous for a high efficiency of the radiation detector.

This correspondingly applies to a further embodiment, according to which a further photocathode section for generating electrons is arranged on an end face of the scintillator.

In a further preferred embodiment, the radiation detector also includes an electrode arrangement for bringing about a movement of generated electrons to the microchannel plate. As a result, the electrons generated by the photocathode section(s) may be moved or accelerated reliably in the direction of the microchannel plate.

The electrode arrangement may include a first electrode, which is arranged in the region of an end face of the scintillator, and a second electrode, which is arranged on the microchannel plate. As a result, the radiation detector may have a relatively compact construction.

The second electrode may be embodied in the form of a structured layer and has openings via which channels of the microchannel plate are exposed. In this configuration, the electrons emitted by the photocathode section(s) may be accelerated to the second electrode and impinge on the second electrode with further electrons being liberated. Via the openings in the second electrode, the electrons may enter into the channels of the microchannel plate and be multiplied further here.

In a further embodiment, the microchannel plate is configured for multiplying electrons generated by different photocathode sections. For this purpose, the microchannel plate may, for example, be arranged in the region of an end face of the scintillator and be provided with larger lateral dimensions than the scintillator. In this way, electrons coming from different photocathode sections may pass to channels in different regions or segments of the microchannel plate, and may be multiplied here.

In a further embodiment, the detection device is configured for separately detecting electrons generated and multiplied by

different photocathode sections. This affords the possibility of accurately detecting the lateral location of an interaction of a radiation quantum interacting with the scintillator. For this purpose, the detection device may, for example, be subdivided into different regions or segments. One or a plurality of trapping electrodes are arranged in each segment.

In a further embodiment, the scintillator, the microchannel plate, and the detection device are arranged one above another. As a result, a compact detector construction having small lateral dimensions may be made possible.

In a further embodiment, the radiation detector includes a first and a second photocathode section arranged in each case on a lateral wall of the scintillator and serving for generating electrons. The radiation detector also includes a first microchannel plate and a second microchannel plate for multiplying electrons. An electrode arrangement configured to bring about a movement of electrons generated by the first photocathode section to the first microchannel plate and electrons generated by the second photocathode section to the second microchannel plate is provided. The radiation detector includes a first detection device for detecting electrons multiplied by the first microchannel plate, and a second detection device for detecting electrons multiplied by the second microchannel plate. This configuration of the radiation detector affords the possibility of detecting the height or depth of an interaction in the scintillator. With regard to a parallelepipedal configuration of the scintillator having four lateral walls, for example, two of the photocathode sections adjoining (e.g., angularly adjoining) one another may constitute a first photocathode section, and the other two photocathode sections adjoining (e.g., angularly adjoining) one another may constitute a second photocathode section.

In a further embodiment, the radiation detector includes a number of a plurality of scintillators that are arranged alongside one another and on the lateral walls of which photocathode sections for generating electrons are arranged. A microchannel plate for multiplying electrons generated by photocathode sections of the plurality of scintillators, and a detection device for detecting electrons multiplied by the microchannel plate may also be provided. Such a modular configuration in which the microchannel plate and the detection device are assigned to the plurality of scintillators may be realized relatively cost-effectively, if appropriate.

Such a modular configuration also affords the possibility, with a corresponding electrode arrangement, of bringing about different movements of electrons emitted at lateral walls of the plurality of scintillators, and of assigning a first and second microchannel plate and a first and second detection device to the scintillators in a manner comparable to the embodiment described above.

An imaging system that includes a radiation detector in accordance with one of the embodiments described above, and in which, therefore, the advantages described above may likewise be manifested. Such an imaging system may be, for example, an X-ray or computed tomography system or else a positron emission tomography or single photon emission computed tomography system. With regard to such imaging systems, provision may be made for the above-described detector construction or one of the above-described embodiments to constitute in each case an individual detector element or a "pixel" of an associated detector, and for a number of such detector elements or "pixels" to be arranged alongside one another, for example, in a planar fashion and/or in a circular or partly circular fashion.

BRIEF DESCRIPTION OF THE DRAWINGS

FIG. 1 shows a schematic illustration of one embodiment of an X-ray system;

FIG. 2 shows a schematic perspective illustration of exemplary constituent parts of a detector element including photocathode sections on lateral walls of a scintillator;

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FIG. 3 shows a schematic perspective illustration of a further embodiment of a detector element constructed in accordance with the components from FIG. 2;

FIG. 4 shows a schematic lateral illustration of an enlarged excerpt from the detector element from FIG. 3;

FIG. 5 shows a schematic perspective illustration of a further detector element, configured for segment-by-segment detection of electrons, where the electrons are generated by different photocathode sections;

FIG. 6 shows a schematic plan view of one embodiment of an electrode arrangement of a detection device used in the detector element from FIG. 5;

FIG. 7 shows a schematic perspective illustration of exemplary components of a further detector element, configured to move electrons generated by different photocathode sections in different directions;

FIG. 8 shows a schematic plan view of one embodiment of an electrode arrangement used in the detector element from FIG. 7 for bringing about the different electron movements;

FIG. 9 shows a schematic perspective illustration of the detector element constructed in accordance with the components of FIGS. 7 and 8;

FIG. 10 shows a schematic perspective illustration of a further detector element including a plurality of scintillators arranged alongside one another;

FIG. 11 shows a schematic lateral illustration of the plurality of scintillators of the detector element from FIG. 10; and

FIG. 12 shows a schematic perspective illustration of a further detector element including a plurality of scintillators arranged alongside one another, where the detector element is configured to bring about electron movements in different directions.

DETAILED DESCRIPTION

Embodiments of a detector or detector element that may be used to detect electromagnetic radiation (e.g., high-energy radiation such as X-ray or gamma radiation) are described with reference to the following figures. In order to produce the embodiments described, method processes known from the field of semiconductor and detector technology may be carried out and customary materials may be used, so the known method processes will be discussed only in part.

The detector concept described here is provided for use in association with imaging systems related to medical technology. In systems of this type, two- or three-dimensional image data of organs and structures of the human body are generated based on measurement signals obtained with the aid of a corresponding radiation detector.

For exemplary elucidation, FIG. 1 illustrates an X-ray system 110 that may be used for diagnostic and interventional imaging. The X-ray system 110 includes a radiation source 111 for emitting X-ray radiation (“X-ray emitter”) and an associated detector 100 of planar construction (“flat detector”) for detecting the radiation. Radiation source 111 and detector 100 are arranged opposite one another at the ends of a C-shaped holding device 112. On account of this configuration, this arrangement is also designated as “C-arc” or “C-arm”.

A patient to be examined is situated on a patient supporting couch 117 and in this case is arranged between radiation source 111 and detector 100. During the operation of the X-ray system 110, the body or a body section of the patient is radiographed with the X-ray radiation generated by the radiation source 111, and the non-absorbed, transmitted portion of radiation is detected by the detector 100.

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The holding device 112 is also fixed to a robot 113 provided with a plurality of axes and/or articulations. The radiation source 111 and the detector 100 may be brought to a desired position in relation to the patient with the aid of the robot 113.

For controlling the X-ray system 110 and for processing and/or evaluating measurement signals of the detector 100 (e.g., for generating the desired image data), the X-ray system 110 also includes a control and/or evaluation device 114. The control and/or evaluation device 114 is connected to a corresponding display device or a display, as is indicated in FIG. 1.

Alongside the X-ray system 110 from FIG. 1, the detector concept described below may also be used in association with other imaging systems (not illustrated). By way of example, systems including a gantry, such as a computed tomography system (CT), for example, are appropriate. Such a system may include an annular or circular-cylindrical detector and a rotatable X-ray source. Further exemplary applications with a gantry include positron emission tomography systems (PET) and single photon emission computed tomography systems (SPECT). In this case, the patient to be examined is injected with a radiopharmaceutical that generates gamma quanta either directly (SPECT) or indirectly (PET) through emission of positrons. The quanta may be detected likewise by an annular or circular-cylindrical detector.

FIG. 2 shows a schematic perspective illustration of a basic construction of a detector element 101 that may be used for detecting incident high-energy radiation. The embodiments of detector elements described further below with reference to the other figures are constructed based on the detector principle shown here, and the aspects described below may also apply to these embodiments. A radiation detector of an imaging system (e.g., the detector 100 of the system 110 from FIG. 1) may include a number of detector elements constructed in this way. The detector elements may be arranged alongside one another in the form of “pixels” in a matrix-like manner. In this case, for example, planar, but also annular or partly annular arrangements may be present. The image data respectively desired may be generated based on the measurement signals generated by the individual pixels or detector elements of a detector.

As is illustrated in FIG. 2, the detector element 101 includes a scintillator 120 that serves to convert the high-energy radiation to be detected into a low(er)-energy radiation. The scintillator 120 is embodied in a parallelepipedal fashion and has two mutually opposite end faces 121, 122 and four lateral walls 123 between the two end faces 121, 122. The lateral walls adjoin one another at a right angle. The end face 122 directed toward the top in FIG. 2 is also designated hereinafter as “front side,” and the end face 121 directed toward the bottom is designated as “rear side” of the scintillator 120. Front and rear sides 122, 121 are connected to one another via the lateral walls 123 at the periphery or edge.

As indicated in FIG. 2, the scintillator 120 has a high aspect ratio (e.g., a high ratio of height (distance between the end faces 121, 122) to width (lateral dimension or distance between two mutually opposite lateral walls 123)), which is greater or significantly greater than one. In this way, a high absorption of the high-energy radiation may be detected, which is indicated based on a radiation quantum 200 in FIG. 2, in the scintillator 120. In this connection, the components illustrated in FIG. 2, but also in the other figures, and corresponding dimensions may be illustrated in a manner not true to scale. By way of example, the scintillator 120 may have a larger height or a larger aspect ratio.

During the operation of the detector element 101, the front side 122 of the scintillator 120 faces the radiation to be detected, such that the radiation may be incident or coupled

into the scintillator **120** via the front side **122**. A radiation quantum **200** (e.g., X-ray quantum or gamma quantum) of the incident radiation may bring about an excitation locally upon passing through the scintillator **120**. The excitation energy deposited or absorbed during this process is reemitted by the scintillator **120** in the form of lower-energy radiation quanta or photons **202**. In this case, the number of emitted photons **202** may be proportional to the original energy of the radiation quantum **200** that interacts with the scintillator material. The scintillation mechanism that takes place in this case will not be discussed in more specific detail. The scintillation radiation generated by the scintillator **120** may be visible or ultraviolet light, for example.

Alongside radiation emission in the direction of the end faces **121**, **122** of the scintillator **120**, a large part of the scintillation radiation or photons **202** generated in the scintillator **120** is emitted in the direction of the lateral walls **123**. This is the case, for example, if the scintillator **120**, as in the present case, has a high aspect ratio, and, consequently, the lateral walls **123** have a relatively large surface area in comparison with the end faces **121**, **122** of the scintillator **120**. In the case of the detector element **101**, provision is made for utilizing, for example, this significant portion of radiation at the lateral walls **123** for detecting radiation. As a result of this, a high efficiency may be achieved.

The detector element **101** includes for this purpose a respective photocathode section **130** on all four lateral walls **123**, by which photocathode sections photons **202** emitted to the lateral walls **123** and emerging at the lateral walls **123** may be converted into electrons **204** (e.g., photoelectrons) with use being made of the photoelectric effect. For each photon **202** that impinges on a photocathode section **130** and is absorbed here, the relevant photocathode section **130** may emit an electron **204**.

For reasons of clarity, only three photocathode sections **130** provided on lateral walls **123** are illustrated in FIG. 2. The sections are also provided with the reference signs **130a**, **130b** and **130c** for differentiation. These reference signs in part are also used in the other figures. In this case, the addition “a” refers to the section **130** arranged on the left, the addition “b” refers to the section **130** offset toward the rear with respect to the plane of the drawing, and the addition “c” refers to the section **130** arranged on the right. In the other figures, by contrast, the designation “d” is provided for a fourth photocathode section **130** that is not shown in FIG. 2 and is arranged at the front in the plane of the drawing.

Each of the photocathode sections **130**, in a departure from the spaced-apart illustration of FIG. 2, is arranged directly on a respective lateral wall **123** of the scintillator **120**. The layer-type photocathode sections **130** may have substantially the same surface area as the relevant lateral walls **123**, such that all lateral walls **123** are substantially completely covered by the photocathode sections **130**. In this case, the photocathode sections **130** may be present in the form of a continuous layer (e.g., peripherally) enclosing the scintillator **120**.

The photocathode sections **130** constitute semitransparent photocathodes or transmission photocathodes that operate transmissively. In this case, the photocathode sections **130** are irradiated at the side facing the scintillator **120** or bearing on the lateral walls **123** thereof, and electrons **204** are emitted at an opposite side of the photocathode sections **130** with respect thereto. This is elucidated in FIG. 2 with the aid of the right-hand photocathode section **130c**. The direct arrangement of the photocathode sections **130** on the lateral walls **123** of the scintillator **120** likewise contributes to the high efficiency of the detector element **101**. What may be achieved in this configuration is that the scintillation radiation passing to

the lateral walls **123** and emerging at the lateral walls **123** is directly taken up or absorbed by the photocathode sections **130** and converted into electrons **204**. Radiation reflection and the situation where the radiation is “reflected back and forth” in the scintillator **120**, associated with corresponding loss processes, may be avoided (e.g., largely avoided) in this case. To put it another way, the first “contact” of a photon **202** with a lateral wall **123** may lead to the generation of an electron **204**.

The configuration of the scintillator **120** with the photocathode sections **130** on the lateral walls **123** thus affords the possibility of obtaining rapid access to a large number of scintillation photons **202** by an extremely short route. In this way, the detector element **101** may have a high efficiency and a high temporal resolution. These advantages correspondingly also hold true for a detector constructed from a plurality of such detector elements **101**, and thus for an associated imaging system. This affords the possibility, for example, of exposing a patient to be examined only to a low radiation dose.

Alongside the scintillator **120** and the photocathodes **130** arranged thereon, the detector element **101** also includes an arrangement composed of two electrodes **140**, **150**, a microchannel plate **161** having a multiplicity of microchannels, and a detection device **171**. With the aid of the two electrodes **140**, **150**, an electric field E is generated in order to bring about a movement of the electrons **204** generated photoelectrically at the lateral walls **123** of the scintillator **120** to the microchannel plate **161**. This is likewise elucidated in FIG. 2 only with the aid of the right-hand lateral wall **123** provided with the photocathode section **130c**. In this case, the electrode **140** may constitute a cathode, and the other electrode **150** may constitute an associated anode or dynode, on which the electrons **204** may impinge with further electrons **204** being liberated. The electrodes **140**, **150** may also be embodied and positioned with respect to one another such that the direction of the electric field E runs parallel to the longitudinal axis of the scintillator **120**.

In order that the electrons **204** may pass to the microchannel plate **161** arranged below the electrode **150**, the electrode **150** may be provided with corresponding openings (not illustrated in FIG. 2). The electrode **150** (in a departure from the illustration of FIG. 2) may be arranged directly on the microchannel plate **161**. The electrons **204** passing to the microchannel plate **161** may be rapidly multiplied in the channels thereof and subsequently trapped and detected with the aid of the detection device **171** arranged below the microchannel plate **161**, or with the aid of one or more readout electrodes (e.g., “readout pad”) provided and serving as anodes. A corresponding output signal may be generated based on this. The detection device **171** may (in a departure from the illustration in FIG. 2) be directly connected to the microchannel plate **161**. These and further possible details concerning the components **140**, **150**, **161**, **171** and the functioning thereof will be discussed even more thoroughly in connection with FIGS. 3 and 4.

The above-described functioning of the detector element **101** requires the presence of an evacuated atmosphere or a vacuum at least in that region in which free electrons **204** are present (e.g., starting from the generation at the lateral walls **123** of the scintillator **120** with the photocathode sections **130** through to detection with the aid of the detection device **170**). In FIG. 2, and also in the further figures, the presence of such an evacuated environment or a vacuum **190** is indicated with the aid of broken lines. The provision of the evacuated environment **190** may be made possible, for example, with a corresponding housing (not illustrated).

FIG. 3 shows a schematic perspective illustration of one embodiment of a detector element **102** constructed from the constituent parts described above. FIG. 4 shows a schematic lateral illustration of an enlarged excerpt from the detector element **102**, based on which further possible details of the detector element **102** become clear. As is illustrated in FIG. 3, the electrode **140**, the scintillator **120** coated with the photocathodes **130**, the other electrode **150**, the microchannel plate **161** and the detection device **171** are arranged one above another with respect to one another in the case of the detector element **102**. In this way, the detector element **102** may have a relatively compact construction with small lateral dimensions.

The electrode **140**, which may be embodied in the form of a rectangular or square plate, is arranged in the region of the front side **122** or on the front side **122** of the parallelepipedal scintillator **120**. The other electrode **150**, as shown in FIG. 4, is embodied in the form of a structured layer arranged on a side of the microchannel plate **161** situated opposite the rear side **121** of the scintillator **120**. This side of the microchannel plate **161** is also designated hereinafter as the “front side” of the microchannel plate **161**. Both electrodes **140**, **150** extend substantially parallel to one another, as illustrated in FIG. 3, and project laterally beyond the lateral walls **123** of the scintillator **120** (or planes predefined by the lateral walls **123**). The two electrodes **140**, **150** may have the same or comparable external dimensions.

As a result of the parallel arrangement of the electrodes **140**, **150** and the lateral projection thereof beyond the lateral walls **123** of the scintillator **120**, an electric field E generated with the aid of the two electrodes **140**, **150** runs also laterally with respect to the lateral walls **123** parallel to the longitudinal axis of the scintillator **120**. Using the electric field E , electrons **204** emitted at the lateral walls **123** by the photocathode sections **130** or **130a**, **130b**, **130c**, **130d** in response to the action of the scintillation radiation may be reliably deflected toward the electrode **150** and accelerated in the direction of the electrode **150**. For the generation of the electric field E , corresponding electrical potentials coordinated with one another are applied to the two electrodes **140**, **150**. For this purpose, the detector element **102** includes a suitable connection structure (not illustrated). The potential difference between the electrodes **140**, **150** may be in the high-voltage range, for example.

The microchannel plate **161** arranged on the rear side **121** of the scintillator **120** or situated opposite the rear side **121** has a plate-shaped main body permeated by a plurality (e.g., a few thousand) of microscopically fine channels **165** (see FIG. 4). The channels **165** can be arranged with a close pitch in a pixel-like manner with respect to one another and may be embodied in a manner running parallel to one another. The microchannel plate **161**, in a manner comparable with the two electrodes **140**, **150**, likewise has larger lateral dimensions than the scintillator **120** and extends laterally beyond the lateral walls **123** thereof (or planes predefined by the lateral walls **123**). As a result of this, electrons **204** emitted by the lateral walls **123** may pass to the microchannel plate **161** and be multiplied therein.

The front side of the microchannel plate **161** “coated” with the electrode **150** may be arranged at a distance from the rear side **121** of the scintillator **120**, as shown in FIG. 4, at least in the region illustrated here. In a departure from this, provision may be made for scintillator **120** and microchannel plate **161** to directly adjoin one another at one or a plurality of other locations, such that the scintillator **120** is placed on the front side of the microchannel plate **161**. For this purpose, the microchannel plate **161** may have at the front side, for

example, one or more projecting supporting structures or spacer structures on which the scintillator **120** may bear (not illustrated). At such supporting locations, no coating of the microchannel plate **161** with the electrode **150** is provided.

With reference to FIG. 4, the electrode **150** arranged on the front side of the microchannel plate **161** is embodied in the form of a structured layer and has holes or openings **159**. The channels **165** of the microchannel plate **161** are exposed via the openings **159**, such that electrons **204** may enter into the channels **165** at the front side of the microchannel plate **161**. The microchannel plate **161** is also provided with a structured surface profile at the front side, and has elevations **166** between the channels **165** with a shape or contour decreasing in size (e.g., trapezoidal or tetrahedral shape). In this way, the electrode **150** arranged here likewise has a correspondingly structured or profiled surface shape having, for example, trapezoidal or tetrahedral sections tapering, for example, obliquely toward one another. This configuration makes it possible that electrons **204** (e.g., primary electrons) emitted by the photocathode sections **130** in the direction of the electrode **150** may impinge on the electrode **150** and may eject or liberate further electrons **204** (e.g., secondary electrons) here. The electrons **204** may subsequently enter into the channels **165** of the microchannel plate **161** via the openings **159** and may be multiplied further, as indicated in FIG. 4.

For this purpose, during the operation of the detector element **102**, likewise an electrical voltage (e.g., high voltage) is applied between the front side and a rear side of the microchannel plate **161** situated opposite the front side. As a result of this, an electric field is present along the channels **165**. Electrons **204** entering into a channel **165** at the front side of the microchannel plate **161** are moved or accelerated owing to the electric field in the direction of the rear side of the microchannel plate **161** and thus in the direction of the detection device **171** provided in this region. In this case, the small lateral dimensions of the channels **165** have the effect that the electrons **204** may multiply impact the wall of the relevant channel **165** during this movement. Upon each impact, further electrons **204** may be released or ejected from the channel wall and for their part, may likewise be accelerated within the channel **165** and liberate further electrons **204** as a result of impacts with the channel wall. This process continues over the length of the channel **165** and is therefore associated with an avalanche- or cascade-like increase in electrons **204**, as illustrated in FIG. 4.

The electrons **204** multiplied in accordance with this process in the channels **165** of the microchannel plate **161** impinge on the detection device **171** at the rear side of the microchannel plate **161** and are detected by the detection device. In this case, the detection device **171** may generate a corresponding electrical output signal (e.g., voltage drop across a resistor). Such an output signal is dependent on the number or total charge of the electrons **204** collected in the detection device **171**, and thus on the excitation energy originally deposited in the scintillator **120**.

The detection device **171** may have larger lateral dimensions than the microchannel plate **161**, as shown in FIG. 3. The detection device **171**, as illustrated in FIG. 4, may be connected to the microchannel plate **161** or to the rear side thereof and includes, per channel **165**, a respective corresponding electrode **175** for trapping or collecting multiplied electrons **204**. Alternatively, the detection device **171** may be provided with larger or wider electrodes that are assigned to a plurality of channels **165**. A configuration having an individual or large-area electrode for trapping the electrons **204** multiplied in all the channels **165** of the microchannel plate **161** may also be provided.

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The presence of an acceleration voltage and thus of an electric field along the channels 165 of the microchannel plate 161 requires the application of corresponding electrical potentials to the front and rear side thereof. At the front side of the microchannel plate 161, this may be effected by the electrode 150 arranged here. With regard to the rear side, this may be performed with the aid of the detection device 171 or the electrode(s) 175 thereof.

As is illustrated in the enlarged excerpt illustration in FIG. 4, the detector element 102 includes, alongside the photocathode sections 130 provided on the lateral walls 123 of the scintillator 120, a further (optional) semitransparent photocathode section 131 arranged on the rear side 121 of the scintillator 120. In this case, all the photocathode sections 130, 131 may be present in the form of a continuous coating of the scintillator 120. The photocathode section 131 affords the possibility of additionally utilizing a portion of the scintillation radiation generated in the scintillator that passes to the rear side 121 and of directly converting this into photoelectrons 204. Using the electric field E that is also present in this region, is produced with the aid of the electrodes 140, 150, and is oriented parallel to the longitudinal axis of the scintillator 120, the electrons 204 emitted at the rear side 121 may likewise be accelerated in the direction of the electrode 150. This may be followed once again by the processes described above (e.g., impingement of the electrons 204 on the electrode 150 with liberation of further electrons 204, entry of the electrons 204 into channels 165 of the microchannel plate 161 and multiplication of the electrons, and detection of the multiplied electrons 204 with the aid of the detection device 171). For further details in this regard, reference is made to the description above. With regard to details pertaining to the photocathode section 131, reference is made to the above explanations concerning the other photocathode sections 130, which apply analogously here.

Alongside the above-described utilization of the scintillation radiation emitted, for example, to the lateral walls 123 of the scintillator 120, the use of the microchannel plate 161 used for electron multiplication also contributes to a high detection efficiency. For example, the detector element 102 and 101 may have a low noise proportion and a low dark rate. This is owing to the fact that the production of electron avalanches in the channels 165 of the microchannel plate 161 and thus the generation of a corresponding signal in the detection device 171 take place substantially only if the scintillator 120 emits radiation and the photocathode sections 130, 131 generate photoelectrons 204 in response to the action of the scintillation radiation. The microchannel plate 161 may be embodied with small distances between the microchannels 165, and consequently with a high porosity. This is associated with a high filling factor, which may be significantly higher than in the case of a conventional silicon photomultiplier.

Materials known from semiconductor and detector technology may be used for the constituents of the detector element 102 and 101. By way of example, the electrodes 140, 150 are formed from an electrically conductive or metallic material. The electrode 150 arranged on the microchannel plate 161 may include a material having high secondary electron emission. As a result of this, the impingement of photoelectrons 204 on the electrode 150 may be associated with liberation of a number of further electrons 204 and thus high electron multiplication.

The use of an inorganic material or of a crystal is considered for the scintillator 120. In one embodiment, this involves a "fast" scintillator 120, in which the scintillation mechanism (e.g., the conversion of the incident high-energy radiation into the lower-energy scintillation radiation) takes place in a short

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time duration. One material considered for this purpose is CsF or LSO, for example. With regard to a possible size of the scintillator 120, consideration is given, for example, to lateral dimensions or a width in the range of a few 100 μm to a few mm, and a height in the range of a few mm to a few 10 mm. In this case, the scintillator 120 has an aspect ratio of greater (e.g., significantly greater) than one, which may be greater than 7:1, for example, with regard to PET applications.

Materials such as, for example, CsI, CsTe, Cs₃Sb, diamond and GaN are appropriate for the photocathode sections 130, 131. The photocathode sections 130, 131 and the scintillator 120 or the materials thereof are in this case coordinated with one another such that the scintillation radiation coming from the scintillator 120 may be converted into free electrons 204 in the photocathode sections 130, 131. Since the photocathode sections 130, 131 operate transmissively, as described above, the photocathode sections 130, 131 are also embodied with a relatively small thickness or layer thickness (e.g., in the range of a few 10 nm) on the scintillator 120.

The microchannel plate 161 may include a semiconductor material such as silicon, for example. In this way, the microchannel plate 161 may be produced in a simple manner (e.g., with the aid of a lithographic patterning and etching method). The microchannel plate 161 may also be embodied such that the microchannel plate 161, alongside a basic or starting material (e.g., a semiconductor material such as silicon) also includes even further materials or layers (not illustrated). By way of example, a coating having high secondary electron emission may be provided within the channels 165 in order to be able to liberate a multiplicity of further electrons 204 in the event of wall impacts of electrons 204. The microchannel plate 161, which (like the electrodes 140, 150) has larger lateral dimensions than the scintillator 120, may have, for example, a height (distance between front and rear sides) in the range of a few 100 μm to a few mm. The pores or channels 165 of the microchannel plate 161 may have a width or a diameter of a few μm to a few 10 μm .

With regard to the channels 165, provision may also be made for the channels, contrary to the illustration in FIG. 4, to be arranged in a manner obliquely tilted relative to a normal to a plane predefined by the microchannel plate 161 (or by the front side and/or rear side thereof). In this case, for example, an angle in a range of 10° between the normal to the plate and a longitudinal axis of the channels 165 may be provided. What may be achieved as a result is that the electrons 204 multiply impact the channel walls independently of their entrance angles upon entering into the channels 165 and, consequently, may liberate further electrons 204.

A series of different configurations may be provided for the detection device 171 as well. The detection device 171, which, as shown in FIG. 3, may have larger lateral dimensions than the microchannel plate 161, may be embodied, for example, like the microchannel plate 161 in the form of a semiconductor or silicon substrate with one or more electrodes 175 composed of a conductive or metallic material. In this way, a bonding method known from semiconductor technology may be carried out in order to connect these two components 161, 171. Alternatively, the detection device 171 may also be embodied, for example, in the form of a ceramic carrier provided with one or more electrodes 175.

In a configuration of the detection device 171 having a plurality of electrodes 175, the plurality of electrodes 175 may be present, for example, in the form of rows and columns or in the form of a matrix arrangement. Alternatively, however, other configurations of electrodes may be provided (e.g., in the form of crossed striplines or strip-shaped electrodes ("transmission line system")).

The detection device **171** may also be present in the form of an application specific integrated circuit (ASIC). In this way, the detection device **171** may be configured not only for detecting or reading out a total charge of an electron avalanche and for generating an output signal on the basis thereof, but also for at least partly conditioning or evaluating the same.

One possible modification of the detector element **102** in FIGS. **3** and **4** consists in providing photocathode sections **130** for photoelectrically generating electrons **204** only on the lateral walls **123** of the scintillator **120**, and omitting the photocathode section **131** arranged on the rear side **121** of the scintillator **120**. In this way, the configurations that are described below and are not illustrated may also be considered. This may be realized either jointly or (if appropriate) independently of one another. By way of example, the possibility is afforded that, instead of a whole- or large-area coating of the microchannel plate **161** with the electrode **150**, the electrode **150** is formed only in a frame-shaped region (e.g., laterally with respect to the lateral walls **123** of the scintillator **120**) on the front side of the microchannel plate **161**, since photoelectrons **204** are only emitted by the lateral walls **123**. A frame-shaped configuration is equally possible for the other electrode **140**. The microchannel plate **161** may be provided with channels **165** only in a frame-shaped region corresponding to the frame-shaped electrode **150**. The same applies to the detection device **171**, which may likewise include one or a plurality of trapping electrodes **175** only in a frame-shaped region. The scintillator **120** may also be placed directly on the microchannel plate **161** over the entire rear side **121**, and therefore (in a departure from FIG. **4**), there is no distance between the scintillator **120** and the microchannel plate **161**.

Further possible configurations of detector elements are described with reference to the following figures. In this case, with regard to already described details relating to aspects and components of identical type or corresponding aspects and components, functioning, usable materials, size dimensions, possible advantages, etc., reference is made to the above explanations.

FIG. **5** shows a schematic perspective illustration of a further embodiment of a detector element **103** that is constructed in a manner comparable with the detector element **102** from FIG. **3**. The detector element **103** or the detection device **171** thereof is configured to detect electrons **204** separately from one another. The electrons are generated and subsequently multiplied with the aid of different photocathode sections **130** arranged on lateral walls **123**.

In order to elucidate this functioning, FIG. **5** indicates a subdivision of the electrode **150** into trapezoidal electrode regions or segments **150a**, **150b**, **150c**, **150d** that are present laterally with respect to the lateral walls **123** of the scintillator **120**. The electrode **150** (in a manner corresponding to FIG. **4**) may be formed on the microchannel plate **161** and with openings **159**. The individual segments **150a**, **150b**, **150c**, **150d** are assigned to the photocathode sections **130a**, **130b**, **130c**, **130d** arranged on the different lateral walls **123** of the scintillator **120**. The shown subdivision of the electrode **150**, which may be merely fictitious, is intended to elucidate the fact that the electrons **204** emitted at the different lateral walls **123** may be deflected to the different segments or quadrants **150a**, **150b**, **150c**, **150d** on account of the electric field E generated by the electrodes **140**, **150** and situated parallel to the longitudinal axis of the scintillator **120**. In this case, electrons **204** are accelerated from the photocathode section **130a** to the segment **150a**, from the photocathode section **130b** to the seg-

ment **150b**, from the photocathode section **130c** to the segment **150c**, and from the photocathode section **130d** to the segment **150d**.

In a corresponding manner, the electrons **204** that impinge on the different segments **150a**, **150b**, **150c**, **150d** and are liberated here are multiplied separately from one another or in corresponding fictitious segments of the microchannel plate **161**. This makes it possible for the multiplied electrons **204** also to be detected separately from one another by the detection device **171** arranged (in a manner corresponding to FIG. **4**) on the rear side of the microchannel plate **161**.

For this purpose, the detection device **171** includes separate electrode regions **176a**, **176b**, **176c**, **176d**, as illustrated with reference to the schematic plan view illustration in FIG. **6**. The electrode regions **176a**, **176b**, **176c**, **176d** are assigned to the individual lateral walls **123** of the scintillator **120** or to the photocathode sections **130a**, **130b**, **130c**, **130d** and thus to the "multiplying segments" of the microchannel plate **161** and to the electrode regions **150a**, **150b**, **150c**, **150d** of the electrode **150**. The electrode regions **176a**, **176b**, **176c**, **176d** may therefore be embodied in a trapezoidal fashion. Each electrode region **176a**, **176b**, **176c**, **176d** may in each case have a large-area electrode, or else a plurality of electrodes (e.g., in a manner corresponding to the structure shown in FIG. **4**). The electrons **204** generated and multiplied separately from one another may be detected separately via the electrode regions **176a**, **176b**, **176c**, **176d**. Using this as a basis, corresponding output signals may be generated using the charge quantities detected by the individual electrode regions **176a**, **176b**, **176c**, **176d**.

The separate and segment-by-segment detection of electrons **204** generated and multiplied by different photocathode sections **130a**, **130b**, **130c**, **130d** affords the possibility of determining, simply and accurately, the lateral location of the interaction ("x/y position") of a radiation quantum **200** that excites the scintillator **120** in the scintillator **120**. In this case, it is possible to make use of the fact that the point in time or the temporal development and/or the magnitude of the charge signals obtained by the electrode regions **176a**, **176b**, **176c**, **176d** are/is dependent on the proximity of the interaction to the respective lateral walls **123**. In order to determine the lateral interaction location, summation and/or difference signals may, for example, be formed from the individual signals. For example, in the case of one possible configuration of the detection device **171** in the form of an ASIC circuit, this may be carried out by the detection device **171** itself.

Making it possible to determine a lateral interaction location in a scintillator **120** proves to be expedient for an imaging system in which the associated detector is constructed from a plurality of detector elements **103** constructed in this way. Alongside a high efficiency and a high temporal resolution, the relevant detector may have a high lateral spatial resolution as a result even in the case of relatively large lateral scintillator dimensions.

In the case of the detector element **103** as well, in a manner comparable with the detector element **102**, an optional photocathode section **131** may be provided on the rear side **121** of the scintillator **120**, such that an arrangement as shown in FIG. **4** may be present. In a corresponding manner, the electrons **204** emitted at the rear side **121** may be accelerated to a rectangular region of the electrode **150** enclosed by the segments **150a**, **150b**, **150c**, **150d**, may impinge here with further electrons **204** being liberated, and the electrons **204** may once again be multiplied separately (e.g., separately from the electrons **204** of the other segments **150a**, **150b**, **150c**, **150d**) in the microchannel plate **161**. These electrons **204**, too, may be detected separately by the detection device **171**. For this

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purpose, the detection device 171 may have an optional rectangular electrode region 177 enclosed by the electrode regions 176a, 176b, 176c, 176d, as is indicated in FIG. 6.

The “central” electrode region 177, like the other electrode regions 176a, 176b, 176c, 176d, may have a large-area electrode or else a plurality of electrodes for detecting multiplied electrons 204.

In the case of the detector elements 102, 103 described above, the arrangement including microchannel plate 161 (e.g., with electrode coating 150) and detection device 171 is provided in the region of the rear side 121 of the scintillator 120. Alternatively, however, a configuration of the detector elements 102, 103 that is symmetrical thereto may also be provided. The arrangement including microchannel plate 161 and detection device 171 is provided in the region of the front side 122 of the scintillator 120. In this configuration, the electrode 140, serving as cathode, is arranged at or on the rear side 121 of the scintillator 120, and an optional photocathode section 131 is arranged on the front side 122 of the scintillator 120. In this case, the high-energy radiation to be detected may be transmitted (e.g., without interaction) through the detection device 171, the microchannel plate 161 (e.g., including the electrode 150), and the optional photocathode section 131 and may subsequently be incident in the scintillator 120. The processes described above may once again occur.

A further possible variant includes providing microchannel plates and detection devices on different sides (e.g., on the two end faces 121, 122 of the scintillator 120), and bringing about electron movements in different or mutually opposite directions. This affords the possibility of also detecting the height or depth of an interaction in the scintillator 120. One possible configuration will be explained in greater detail with reference to the following figures.

FIG. 7 shows a schematic perspective illustration of exemplary constituent parts of a further detector element 104. Alongside the parallelepipedal scintillator 120, on the four lateral walls 123 of which respective photocathode sections 130a, 130b, 130c, 130d are arranged for photoelectrically generating electrons 204, the detector element 104 has a mirror-symmetrical electrode arrangement for bringing about different electron movements.

The electrode arrangement includes two L-shaped electrodes 141, 142 in the region of the front side 122 of the scintillator 120, and two further L-shaped electrodes 151, 152 in the region of the rear side 121 of the scintillator 120. In this case, the two electrodes 141, 142, which project laterally beyond the edge of the front side 122 of the scintillator 120 or are present at least in a region laterally with respect to the lateral walls 123, form a frame-shaped structure. In the same way, the other two electrodes 151, 152, which project laterally beyond the edge of the rear side 121 of the scintillator 120 or are present at least in a region laterally with respect to the lateral walls 123, likewise form a frame-shaped structure.

Both the electrodes 141, 151 and the electrodes 142, 152 are arranged parallel to one another and one above another. The electrode pair 141, 151 is arranged in the region of the photocathode sections 130a, 130d, and the other electrode pair 142, 152 is arranged in the region of the photocathode sections 130b, 130c. This relationship is also illustrated in the schematic plan view illustration in FIG. 8.

As is also indicated in FIG. 7, an electric field E in the direction of the bottom electrode 151 may be produced by the two electrodes 141, 151 situated opposite one another. The electrode 141 may constitute a cathode, and the other electrode 151 may constitute an anode or dynode. In this way, the electrons 204 generated by the photocathode sections 130a, 130d may be accelerated downward in the direction of the

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electrode 151. By contrast, an electric field E in the opposite direction (e.g., in the direction of the top electrode 142) may be produced by the other two electrodes 142, 152 situated opposite one another. The electrode 152 may constitute a cathode, and the other electrode 142 may constitute an anode or dynode. In this way, the electrons 204 emitted by photocathode sections 130b, 130c may be accelerated upward in the direction of the electrode 142. The electric fields E generated by the electrode pairs 141, 151 and 142, 152 are once again oriented parallel to the longitudinal axis of the scintillator 120.

FIG. 9 shows a schematic perspective illustration of one embodiment of the detector element 104 having additional constituent parts for detecting the electrons 204 moved in different directions. The detector element 104 includes a first and second microchannel plate 161, 162 and a first and second detection device 171, 172. These components 161, 162, 171, 172 may be constructed in the manner described above with reference to the detector elements 101, 102.

As is shown in FIG. 9, the first microchannel plate 161 is arranged in the region of the rear side 121 of the scintillator 120 or opposite the rear side 121. The two electrodes 151, 152 are arranged on the front side of the microchannel plate 161. In this case, a construction comparable with FIG. 4 may be present. In other words, the electrodes 151, 152 may include a surface profile comparable with the electrode 150 and openings exposing channels of the microchannel plate 161. The scintillator 120 and the microchannel plate 161 may directly adjoin one another. The microchannel plate 161 may include, for example, one or more projecting supporting structures. The detection device 171 provided on the rear side of the microchannel plate 161 may be directly connected to the microchannel plate 161 and may include one or a plurality of trapping electrodes for detecting electrons 204 multiplied in the microchannel plate 161.

A configuration that is symmetrical thereto is provided for the second microchannel plate 162 and the second detection device 172. The second microchannel plate 162 is arranged in the region of the front side 122 of the scintillator 120 or opposite the front side 122. The other two electrodes 141, 142 are arranged on the front side of the microchannel plate 162. In this case, a construction comparable with FIG. 4 may likewise be present. In other words, the electrodes 141, 142 may include a surface profile comparable with the electrode 150 and openings exposing channels of the microchannel plate 162. The scintillator 120 and the microchannel plate 162 may directly adjoin one another. The microchannel plate 162 may likewise include, for example, one or a plurality of projecting supporting structures. The detection device 172 provided on the rear side of the microchannel plate 162 may (contrary to the illustration in FIG. 9) be directly connected to the microchannel plate 162 and may include one or a plurality of trapping electrodes for detecting electrons 204 multiplied in the microchannel plate 162.

During the operation of the detector element 104, the front side 122 of the scintillator 120 may face the high-energy radiation to be detected. The radiation may transmit through the detection device 172 and the microchannel plate 162 and subsequently be incident in the scintillator 120. The scintillation radiation generated owing to an interaction may be converted into electrons 204 at the lateral walls 123 of the scintillator by the photocathode sections 130a, 130b, 130c, 130d. The electrons are accelerated in different directions and to different electrodes 142 or 151 depending on the respectively emitting photocathode section 130a, 130b, 130c, 130d, in the manner described above with reference to FIGS. 7, 8. The electrons 204 impinging on the electrodes 142, 151 may

liberate further electrons **204**. The electrons **204** are furthermore multiplied in the associated microchannel plates **161**, **162** and detected by the associated detection devices **171**, **172**.

In this case, electrons **204** generated by the photocathode sections **130a**, **130d** are accelerated by the electrodes **141**, **151** to the lower microchannel plate **161**, are multiplied, and detected by the detection device **171**. By contrast, the electrons **204** generated by the photocathode sections **130b**, **130c** are accelerated by the electrodes **152**, **142** to the upper microchannel plate **162**, are multiplied, and detected by the detection device **172**.

The detection of electrons **204** or electron avalanches in different directions affords the possibility of determining the height or depth (“Z-position”) of an interaction of a radiation quantum **200** that excites the scintillator **120**. In this case, it is possible to make use of the fact that the point in time or the temporal development and/or the magnitude of the quantities of charge detected via the detection devices **171**, **172** are/is dependent on the proximity of the interaction to the front or rear side **122**, **121** of the scintillator **120**. In this case, too, corresponding summation and/or difference signals may be formed from individual measurement signals obtained by the detection devices **171**, **172**.

As described above, all the electrodes **141**, **142**, **151**, **152** of the detector element **104** may include a structured surface profile and openings for exposing channels of the respective microchannel plates **161**, **162**. This affords the possibility that the electrodes of the two electrode pairs **141**, **142** and **151**, **152** may optionally be used either as cathode or as dynode (to which electrons **204** are accelerated). By way of example, provision may also be made, contrary to the illustration in FIGS. **7** and **9**, for using the electrode pair **141**, **151** to generate an electric field **E** directed upward in the direction of the microchannel plate **162**, and using the electrode pair **142**, **152** to generate an electric field **E** directed downward in the direction of the microchannel plate **161**. The electric field **E** may be determined depending on the voltage respectively applied to the electrode pairs **141**, **151** and **142**, **152**. Consideration may be given, if appropriate, to multiplying and detecting electrons **204** only in one direction. “Unidirectional” electric fields **E** are generated by the electrode pairs **141**, **151** and **142**, **152**. In the case of a function as dynode, the electrons **204** accelerated to the relevant electrode may impinge thereon and liberate further electrons **204**. The electrons **204** may subsequently enter into the channels of the respective microchannel plates **161**, **162** via the openings and may be multiplied.

Instead of such a flexible manner of operation, a fixedly predefined function as cathode and dynode may also be provided for the electrode pairs **141**, **151** and **142**, **152**. In this case, an electrode operated as cathode does not require a structured surface, nor any openings, since no electrons **204** are accelerated to such an electrode either. It is not necessary for a microchannel plate to be provided with channels in the region of such an electrode. With regard to such a fixedly predefined manner of operation of the electrode pairs **141**, **151** and **142**, **152**, therefore, in a departure from the above description, provision may be made for an electrode operated as cathode not to include a surface profile nor to include openings. Thus, an associated microchannel plate also includes no channels, if appropriate, in this region. In this case, the electrode operated as cathode may be present as a planar continuous layer.

With regard to the detector element **104** from FIG. **9**, the possibility is furthermore afforded that, in a manner comparable with the detector element **102**, a further (optional) photocathode layer is provided on one of the end faces **121**, **122**

of the scintillator **120**. If appropriate, both end faces **121**, **122** may also be coated (e.g., partly coated) with a photocathode. In configurations of this type, the detector element **104** may include a corresponding electrode arrangement with the aid of which the electrons **204** emitted at the end face or at the end faces **121**, **122** may also be accelerated in the direction of the associated microchannel plate **161** or **162**. For this purpose, the electrode arrangement having the electrodes **141**, **142**, **151**, **152**, as shown in FIGS. **7** to **9**, may be modified such that corresponding electrodes or electrode layers are also arranged in the regions enclosed in a frame-shaped manner by the electrodes **141**, **142** and the electrodes **151**, **152**. Such electrodes may also be arranged on the microchannel plates **161**, **162** and include (if appropriate) a surface profile and openings.

Instead of embodying a detector element with only a single scintillator **120**, modular configurations of detector elements including a plurality of scintillators **120** arranged alongside one another, which may be constructed in accordance with the approaches demonstrated above, may also be provided. Possible exemplary embodiments that may be realized cost-effectively, if appropriate, and are based on the detector elements **102**, **103**, **104** described above are described in greater detail below. In this case, with regard to details concerning aspects and components of the same type or corresponding aspects and components, reference is made to the above explanations concerning the detector elements **102**, **103**, **104**.

FIG. **10** shows a schematic perspective illustration of a further detector element **105**, which is constructed in a manner comparable with the detector element **102** from FIG. **3** and includes three scintillators **120** arranged alongside one another. The parallelepipedal scintillators **120** are provided with photocathode sections **130** on (all) lateral walls **123**. A further photocathode coating on the rear sides **121** of the scintillators **120** may also be provided.

A plate-shaped electrode **140** used as cathode is arranged in the region of the front sides **122** or on the front sides **122** of the scintillators **120** and extends laterally beyond the edges thereof. Another electrode **150** is arranged on a microchannel plate **161** assigned to the three scintillators **120**. The microchannel plate **161** is arranged in the region of the rear sides **121** of the scintillators **120** or opposite the rear sides **121**. The electrode **150** and the microchannel plate **161** extend laterally beyond the edges of the rear sides **121** of the scintillators **120**. The microchannel plate **161** and the electrode **150** may have a configuration corresponding to FIG. **4**, such that with regard to further details, reference is made to the explanations above. This applies in the same way also to a detection device **171** arranged on the microchannel plate **161**.

Using the electrodes **140**, **150**, an electric field **E** may be generated parallel to the longitudinal axes of the scintillators **120**. Electrons **204** generated photoelectrically at the lateral walls **123** of the scintillators may be accelerated to the electrode **150**. Electrons **204** emitted (if appropriate) at the rear sides **121** may also be accelerated to the electrode **150**. The electrons **204** may once again eject further electrons **204** from the electrode **150**, may be multiplied (further) in the microchannel plate **161**, and may be detected by the detection device **171**.

A movement of electrons also takes place in the gaps between the individual scintillators **120**. For elucidation, FIG. **11** shows a schematic lateral illustration of the three scintillators **120** arranged alongside one another in the detector element **105** from FIG. **10**. The scintillators **120** may be arranged relatively near to one another, as a result of which a loss in the form of radiation quanta **200** that move between the scintillators **120** and therefore do not interact with the scin-

tillators **120** may be largely avoided. By way of example, relatively small distances in the range of a few 10 μm to a few 100 μm between the scintillators **120** may be provided. As is indicated in FIG. **11**, the electrons **204** generated by the photocathode sections **130** at the lateral walls **123**, in the gaps between the scintillators **120**, may likewise be accelerated to the electrode **150** or to the microchannel plate **161**.

With regard to the detector element **105**, the possibility is provided that all electrons **204** that are generated photoelectrically by and come from the scintillators **120** and are multiplied in the microchannel plate **161** are detected jointly by the detection device **171**. Alternatively, electrons **204** that come from the individual scintillators **120** and are multiplied may also be detected independently of one another or separately from one another. For this purpose, the detection device **171** may have electrode regions assigned to the individual scintillators **120**.

The possibility is provided of designing the detector element **105** or the detection device **171** thereof in a manner comparable with the detector element **103** for separately detecting electrons **204** that are generated by different photocathodes **130** or at different lateral walls **123** of a scintillator **120** and are multiplied, such that in this case, too, a lateral interaction location in a scintillator **120** may be determined. For this purpose, the detection device **171** may be provided with a plurality of electrode regions or segments per scintillator **120**, which are assigned to the individual photocathode sections **130** of the scintillators **120**.

In the case of a modular configuration of a detector element including a plurality of scintillators **120**, consideration may also be given to bringing about electron movements in different directions. For exemplary elucidation, FIG. **12** illustrates, in a schematic perspective illustration, a further detector element **106** including three scintillators **120** arranged alongside one another. The detector element is constructed in a manner comparable with the detector element **104** from FIG. **9**. The detector element **106** therefore once again includes an electrode arrangement comprising electrodes **145**, **155** arranged one above another or situated opposite one another. The electrodes **155** are provided on the front side of a first microchannel plate **161**, and the other electrodes **145** are provided on the front side of a second microchannel plate **162**. The first microchannel plate **161** is arranged in the region of the rear sides **121**, and the second microchannel plate **162** is arranged in the region of the front sides **122** of the scintillators **120**. A first detection device **171** is assigned to the first microchannel plate **161**, and a second detection device **172** is assigned to the second microchannel plate **162**.

Using the electrodes **145**, **155** situated opposite one another in pairs, which are embodied partly as L-shaped and partly as T-shaped and which are arranged on different lateral walls **123** or photocathode sections **130** of the scintillators **120**, electric fields E may be produced in different directions or mutually opposite directions. In this way, electrons **204** emitted at different lateral walls **123** of the scintillators **120** may once again be accelerated in different directions, and thus either to the first or to the second microchannel plate **161**, **162**. The electrons **204** multiplied may, for example, be detected by the respective detection devices **171**, **172**. As a result of this, on the basis thereof, a depth or height of interactions in the scintillators **120** may be determined.

The embodiments explained with reference to the figures constitute exemplary embodiments. Alongside the embodiments described and depicted, further embodiments that may include further modifications and/or combinations of features described may be provided. The detectors or detector elements explained with reference to the figures may also

include further structures (not illustrated) alongside the structures shown and described. One possible example is a connection structure that is connected to one or more photocathode sections in order to “compensate” again for the photoelectric emission of electrons by charging the photocathode section or the plurality of photocathode sections.

Furthermore, different materials than those indicated above may be used for a detector element or the components thereof. With regard to alternative materials, instead of a semiconductor material or instead of silicon, for example, consideration may be given to a glass material as basic material for a microchannel plate.

A detector element or the components thereof may have different dimensions than those indicated above, and a detector element or the components thereof may be embodied with other geometries that deviate from the exemplary embodiments shown in the figures. Other geometries may be considered, for example, for electrode arrangements (e.g., for electrode arrangements for bringing about electron movements in opposite directions).

A scintillator **120** may have, instead of a parallelepipedal shape, a different shape having two mutually opposite end faces and at least one lateral wall between the end faces. The end faces are connected to one another via the lateral wall, and a photocathode section may be provided on the lateral wall. One possible example is a scintillator having a cylindrical or circular-cylindrical shape. In this case, a photocathode section may be provided on a lateral wall (e.g., lateral surface) between the end faces of the scintillator. The photocathode section may, for example, completely enclose the scintillator in order to efficiently convert scintillation radiation emitted to the lateral wall into electrons.

With regard to a scintillator having two mutually opposite end faces and a plurality of lateral walls situated therebetween, provision may be made for arranging a photocathode section only on one individual lateral wall or photocathode sections only on a portion of the lateral walls, such that one or more lateral walls are uncoated. In one embodiment, in the case of a scintillator having one or a plurality of lateral walls arranged between two end faces, one or a plurality of lateral walls may be provided with a photocathode section only in a partial region, rather than completely. Provision may also be made for forming photocathode sections only on lateral walls of scintillators, and for leaving the end faces of the scintillators uncoated.

In configurations of this type, a microchannel plate may be embodied such that microchannels are present only in the partial regions to which electrons to be multiplied are actually moved. In a corresponding manner, an electrode that is arranged on a microchannel plate and functions as a dynode and to which photoelectrons are accelerated may be formed only in a partial region on the relevant microchannel plate (or the front side thereof). In a manner comparable therewith, a detection device may include one or a plurality of trapping electrodes only in a region (e.g., a partial region) in which channels or channels utilized for electron multiplication in an associated microchannel plate are present.

In the case of such geometries, configurations, and coatings of a scintillator, the approaches indicated above may be considered in an analogous manner in order, for example, to separately multiply and detect electrons generated by different photocathode sections or by different subsections of a photocathode section. If appropriate, the electrons may be deflected or accelerated in different directions, etc.

In the case of a modular configuration of a detector element, instead of three scintillators **120** arranged alongside one another (see FIGS. **10**, **12**), other numbers of scintillators

120 arranged alongside one another may also be provided. In this case, there is also the possibility of the scintillators 120 being arranged alongside one another, for example, in a matrix-type fashion in the form of rows and columns. In this case, the parallelepipedal configuration of the scintillators 120, as shown in the figures, proves to be advantageous for arranging the scintillators 120 alongside one another relatively closely and with small gaps.

Although the invention has been described and illustrated more specifically in detail using exemplary embodiments, the invention is nevertheless not restricted by the examples disclosed. Other variations may be derived therefrom by a person skilled in the art without departing from the scope of protection of the invention.

The invention claimed is:

1. A radiation detector comprising:

a scintillator for generating electromagnetic radiation in response to action of incident radiation, wherein the scintillator has two mutually opposite end faces and a lateral wall between the two mutually opposite end faces;

a photocathode section arranged on the lateral wall of the scintillator, the photocathode section being configured to generate electrons in response to action of the electromagnetic radiation generated by the scintillator;

a microchannel plate having a plurality of channels for multiplying the electrons generated by the photocathode section; and

a detection device for detecting the electrons multiplied by the microchannel plate,

wherein the scintillator is configured in a parallelepipedal fashion and has four lateral walls between the end faces, and

wherein a photocathode section for generating electrons is arranged on each of the four lateral walls of the scintillator.

2. The radiation detector of claim 1, wherein a further photocathode section for generating electrons is arranged on an end face of the scintillator.

3. The radiation detector of claim 1, further comprising an electrode arrangement for bringing about a movement of generated electrons to the microchannel plate.

4. The radiation detector of claim 3, wherein the electrode arrangement comprises:

a first electrode that is arranged in a region of an end face of the scintillator; and

a second electrode that is arranged on the microchannel plate.

5. The radiation detector of claim 4, wherein the second electrode is configured in the form of a structured layer and has openings via which channels of the microchannel plate are exposed.

6. The radiation detector of claim 1, wherein the microchannel plate is configured for multiplying electrons generated by different photocathode sections.

7. The radiation detector of claim 1, wherein the detection device is configured for separately detecting electrons generated and multiplied by different photocathode sections.

8. The radiation detector of claim 1, wherein the scintillator, the microchannel plate, and the detection device are arranged one above another.

9. The radiation detector of claim 1, wherein the microchannel plate is a first microchannel plate, and the detection device is a first detection device, and

wherein the radiation detector further comprises:

a first photocathode section and a second photocathode section arranged on a lateral wall of the four lateral walls of the scintillator and configured for generating electrons;

a second microchannel plate for multiplying electrons; an electrode arrangement configured to bring about a movement of electrons generated by the first photocathode section to the first microchannel plate and electrons generated by the second photocathode section to the second microchannel plate;

a first detection device for detecting electrons multiplied by the first microchannel plate; and

a second detection device for detecting electrons multiplied by the second microchannel plate, the first detection device being for detecting electrons multiplied by the first microchannel plate.

10. The radiation detector of claim 1, further comprising: a plurality of scintillators that are arranged alongside one another and on the lateral walls of which are arranged photocathode sections for generating electrons, the plurality of scintillators comprising the scintillator,

wherein the microchannel plate for multiplying is configured to multiply electrons generated by photocathode sections of the plurality of scintillators, and

wherein the detection device for detecting is configured to detect the electrons generated by the photocathode sections of the plurality of scintillators and multiplied by the microchannel plate.

11. An imaging system comprising:

a radiation detector comprising:

a scintillator for generating electromagnetic radiation in response to the action of incident radiation, wherein the scintillator has two mutually opposite end faces and a lateral wall between the end faces;

a photocathode section arranged on the lateral wall of the scintillator and serving for generating electrons in response to the action of the electromagnetic radiation generated by the scintillator;

a microchannel plate having a plurality of channels for multiplying the electrons generated by the photocathode section; and

a detection device for detecting the electrons multiplied by the microchannel plate,

wherein the scintillator is configured in a parallelepipedal fashion and has four lateral walls between the end faces, and

wherein a photocathode section for generating electrons is arranged on each of the four lateral walls of the scintillator.

* * * * *

UNITED STATES PATENT AND TRADEMARK OFFICE
CERTIFICATE OF CORRECTION

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DATED : August 4, 2015
INVENTOR(S) : Hedler et al.

Page 1 of 1

It is certified that error appears in the above-identified patent and that said Letters Patent is hereby corrected as shown below:

In the claims:

Column 22, claim 10, line 30, delete “for multiplying” before “is configured”.

Column 22, claim 10, line 33, delete “for detecting” before “is configured”.

Signed and Sealed this
Nineteenth Day of January, 2016



Michelle K. Lee
Director of the United States Patent and Trademark Office